
USB 2.0 Hi-Speed 4-Port Hub Controller

Highlights

- Hub Controller IC with 4 downstream ports
- USB-IF Battery Charger revision 1.2 support on up & downstream ports (DCP, CDP, SDP)
 - Device OTP configured with battery charging enabled
- Flexible OTP register architecture to enable/disable features
- Battery charging support for Apple® devices
- **FlexConnect**: Downstream port 1 able to swap with upstream port, allowing host capable devices to control other devices on the hub
- USB to I²C/GPIO bridge endpoint support
- USB Link Power Management (LPM) support
- SUSPEND pin for remote wakeup indication to host
- Vendor Specific Messaging (VSM) support
- Enhanced OEM configuration options available through a single serial I²C EEPROM, OTP, or SMBus Device Port
- 36-pin (6x6mm) SQFN, RoHS compliant package

Target Applications

- Multi-function USB peripherals
- PC media drive bay
- Portable hub boxes
- Embedded systems
- Consumer media hub in automotive
- Automotive head units

Additional Features

- **MultiTRAK™**
 - Dedicated Transaction Translator per port
- PortMap
 - Configurable port mapping and disable sequencing
- PortSwap
 - Configurable differential intra-pair signal swapping
- **PHYBoost™**
 - Programmable USB transceiver drive strength for recovering signal integrity
- **VariSense™**
 - Programmable USB receiver sensitivity
- Low power operation
- Full Power Management with individual or ganged power control of each downstream port
- Built-in Self-Powered or Bus-Powered internal default settings provide flexibility in the quantity of USB expansion ports utilized without redesign
- Supports “Quad Page” configuration OTP flash
 - Four consecutive 200 byte configuration pages
- Fully integrated USB termination and Pull-up/Pull-down resistors
- On-chip Power On Reset (POR)
- Internal 3.3V and 1.2V voltage regulators
- On Board 24MHz Crystal Driver, Resonator, or External 24MHz clock input
- Environmental
 - AEC-Q100 Grade3 (-40°C to +85°C)

TO OUR VALUED CUSTOMERS

It is our intention to provide our valued customers with the best documentation possible to ensure successful use of your Microchip products. To this end, we will continue to improve our publications to better suit your needs. Our publications will be refined and enhanced as new volumes and updates are introduced.

If you have any questions or comments regarding this publication, please contact the Marketing Communications Department via E-mail at docerrors@microchip.com. We welcome your feedback.

Most Current Data Sheet

To obtain the most up-to-date version of this data sheet, please register at our Worldwide Web site at:

<http://www.microchip.com>

You can determine the version of a data sheet by examining its literature number found on the bottom outside corner of any page. The last character of the literature number is the version number, (e.g., DS30000000A is version A of document DS30000000).

Errata

An errata sheet, describing minor operational differences from the data sheet and recommended workarounds, may exist for current devices. As device/documentation issues become known to us, we will publish an errata sheet. The errata will specify the revision of silicon and revision of document to which it applies.

To determine if an errata sheet exists for a particular device, please check with one of the following:

- Microchip's Worldwide Web site; <http://www.microchip.com>
- Your local Microchip sales office (see last page)

When contacting a sales office, please specify which device, revision of silicon and data sheet (include -literature number) you are using.

Customer Notification System

Register on our web site at www.microchip.com to receive the most current information on all of our products.

Table of Contents

1.0 Introduction	4
2.0 Acronyms and Definitions	6
3.0 Pin Descriptions	7
4.0 Power Connections	17
5.0 Modes of Operation	18
6.0 Device Configuration	22
7.0 Device Interfaces	26
8.0 Functional Descriptions	28
9.0 Operational Characteristics	34
10.0 Package Information	41
Appendix A: Data sheet Revision History	43
The Microchip Web Site	44
Customer Change Notification Service	44
Customer Support	44
Product Identification System	45

1.0 INTRODUCTION

The USX2534R is a low-power, OEM configurable, MTT (Multi-Transaction Translator) USB 2.0 hub controller with 4 downstream ports and advanced features for embedded USB applications. The USX2534R is fully compliant with the USB 2.0 Specification, USB 2.0 Link Power Management Addendum and will attach to an upstream port as a Full-Speed hub or as a Full-/Hi-Speed hub. The 4-port hub supports Low-Speed, Full-Speed, and Hi-Speed (if operating as a Hi-Speed hub) downstream devices on all of the enabled downstream ports.

The USX2534R has been specifically optimized for embedded systems where high performance, and minimal BOM costs are critical design requirements. Standby mode power has been minimized and reference clock inputs can be aligned to the customer's specific application. Additionally, all required resistors on the USB ports are integrated into the hub, including all series termination and pull-up/pull-down resistors on the D+ and D– pins.

The USX2534R supports both upstream battery charger detection and downstream battery charging. The USX2534R integrated battery charger detection circuitry supports the USB-IF Battery Charging (BC1.2) detection method and most Apple devices. These circuits are used to detect the attachment and type of a USB charger and provide an interrupt output to indicate charger information is available to be read from the device's status registers via the serial interface. The USX2534R provides the battery charging handshake and supports the following USB-IF BC1.2 charging profiles:

- DCP: Dedicated Charging Port (Power brick with no data)
- CDP: Charging Downstream Port (1.5A with data)
- SDP: Standard Downstream Port (0.5A with data)
- Custom profiles loaded via SMBus or OTP

The USX2534R provides an additional USB endpoint dedicated for use as a USB to I²C/GPIO interface, allowing external circuits or devices to be monitored, controlled, or configured via the USB interface. Additionally, the USX2534R includes many powerful and unique features such as:

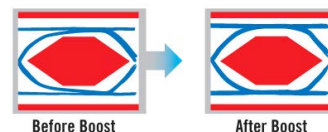
FlexConnect, which provides flexible connectivity options. The USX2534R's downstream port 1 can be swapped with the upstream port (port 0), allowing host-capable devices connected to port 1 to control other devices on the hub.

MultiTRAK™ Technology, which utilizes a dedicated Transaction Translator (TT) per port to maintain consistent full-speed data throughput regardless of the number of active downstream connections. MultiTRAK™ outperforms conventional USB 2.0 hubs with a single TT in USB full-speed data transfers.

PortMap, which provides flexible port mapping and disable sequences. The downstream ports of a USX2534R hub can be reordered or disabled in any sequence to support multiple platform designs with minimum effort. For any port that is disabled, the USX2534R hub controllers automatically reorder the remaining ports to match the USB host controller's port numbering scheme.

PortSwap, which adds per-port programmability to USB differential-pair pin locations. PortSwap allows direct alignment of USB signals (D+/D–) to connectors to avoid uneven trace length or crossing of the USB differential signals on the PCB.

PHYBoost, which provides programmable levels of Hi-Speed USB signal drive strength in the downstream port transceivers. PHYBoost attempts to restore USB signal integrity in a compromised system environment. The graphic on the right shows an example of Hi-Speed USB eye diagrams before and after PHYBoost signal integrity restoration.



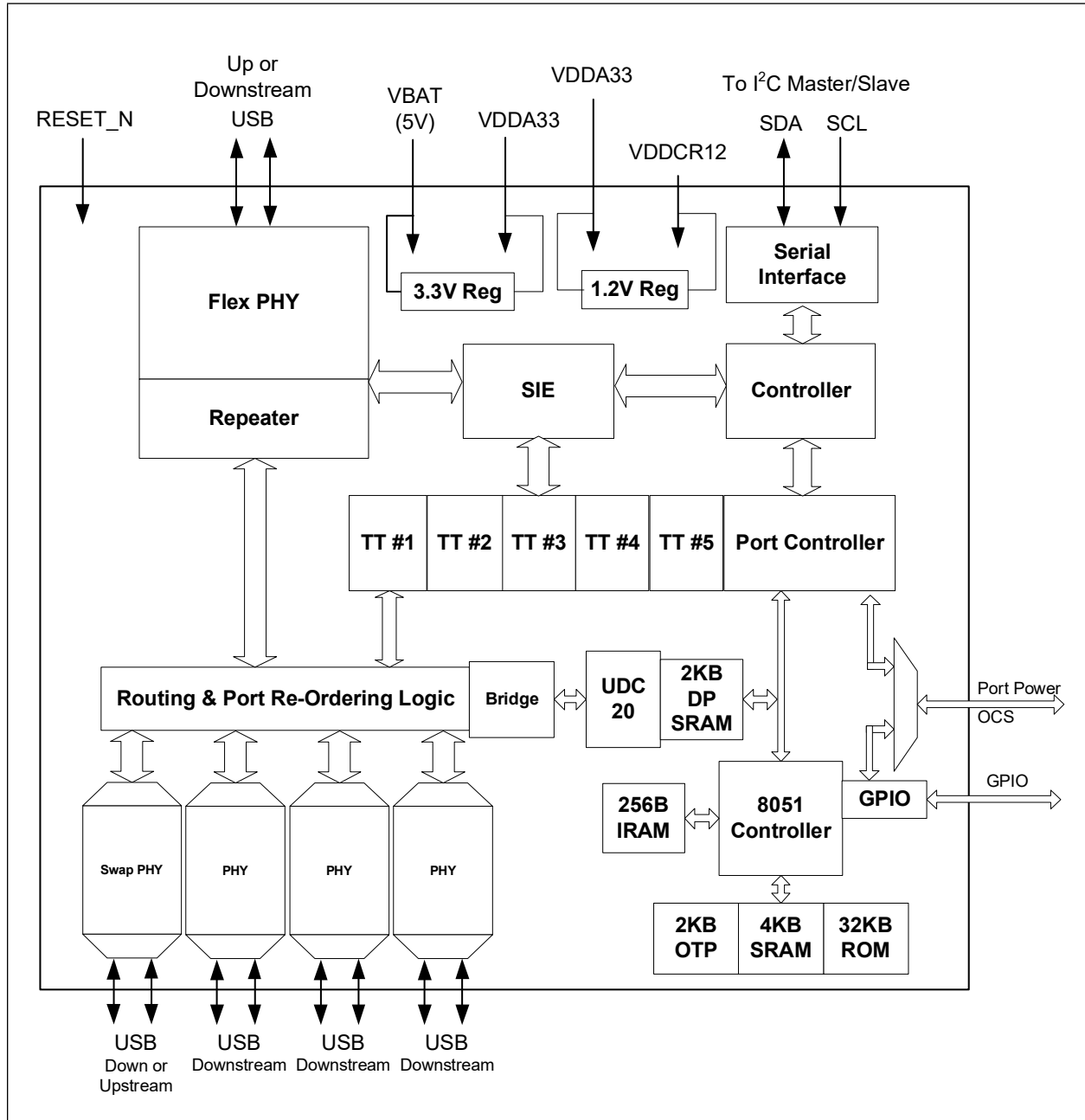
VariSense, which controls the USB receiver sensitivity enabling programmable levels of USB signal receive sensitivity. This capability allows operation in a sub-optimal system environment, such as when a captive USB cable is used.

The USX2534R is available in AEC-Q100 Grade 3 (–40°C to +85°C) temperature range versions.

1.1 Block Diagram

Figure 1-1 details the internal block diagram of the USX2534R.

FIGURE 1-1: SYSTEM BLOCK DIAGRAM



2.0 ACRONYMS AND DEFINITIONS

2.1 Acronyms

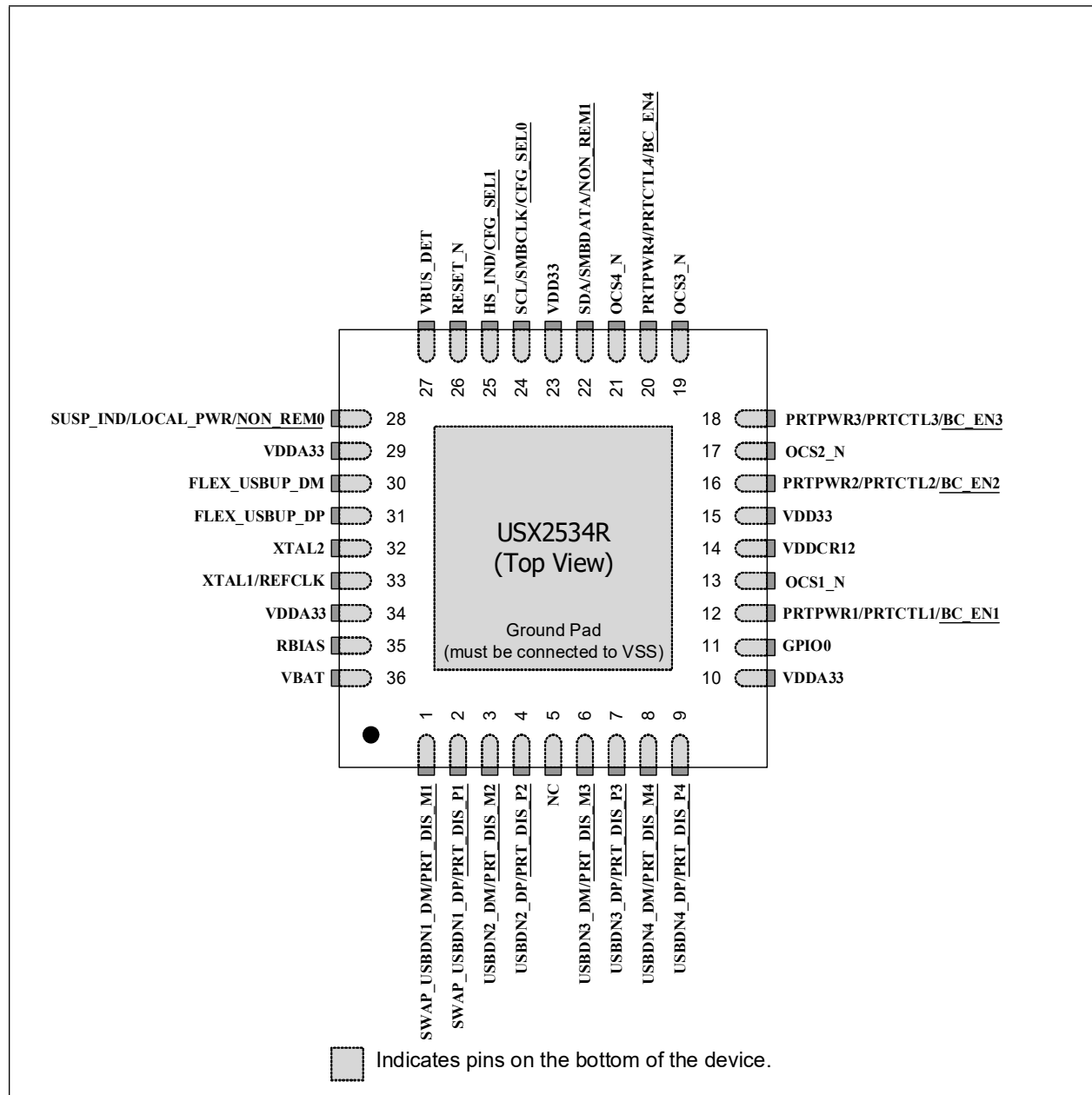
EOP:	End of Packet
EP:	Endpoint
FS:	Full-Speed
GPIO:	General Purpose I/O (that is input/output to/from the device)
HS:	Hi-Speed
HSOS:	High Speed Over Sampling
I²C:	Inter-Integrated Circuit
LS:	Low-Speed
OTP:	One Time Programmable
PCB:	Printed Circuit Board
PCS:	Physical Coding Sublayer
PHY:	Physical Layer
SMBus:	System Management Bus
UUID:	Universally Unique IDentification

2.2 Reference Documents

1. *UNICODE UTF-16LE For String Descriptors* USB Engineering Change Notice, December 29th, 2004, <http://www.usb.org>
2. *Universal Serial Bus Specification*, Revision 2.0, April 27th, 2000, <http://www.usb.org>
3. *Battery Charging Specification*, Revision 1.2, Dec. 07, 2010, <http://www.usb.org>
4. *I²C-Bus Specification*, Version 1.1, <http://www.nxp.com>
5. *System Management Bus Specification*, Version 1.0, <http://smbus.org/specs>

3.0 PIN DESCRIPTIONS

FIGURE 3-1: 36-SQFN PIN ASSIGNMENTS



3.1 Pin Descriptions

This section provides a detailed description of each pin. The signals are arranged in functional groups according to their associated interface.

The “_N” symbol in the signal name indicates that the active, or asserted, state occurs when the signal is at a low voltage level. For example, RESET_N indicates that the reset signal is active low. When “_N” is not present after the signal name, the signal is asserted when at the high voltage level.

The terms assertion and negation are used exclusively. This is done to avoid confusion when working with a mixture of “active low” and “active high” signals. The term assert, or assertion, indicates that a signal is active, independent of whether that level is represented by a high or low voltage. The term negate, or negation, indicates that a signal is inactive.

Note: The buffer type for each signal is indicated in the BUFFER TYPE column of [Table 3-1](#). A description of the buffer types is provided in [Section 3.3](#).

Note: Compatibility with the UCS100x family of USB port power controllers requires the UCS100x be connected on Port 1 of the USX2534R. Additionally, both P RTPWR1 and OCS1_N must be pulled high at Power-On Reset (POR).

TABLE 3-1: PIN DESCRIPTIONS

Num Pins	Name	Symbol	Buffer Type	Description
USB/HSIC INTERFACES				
1	Upstream USB D+ (Flex Port 0)	FLEX_USBUP_DP	AIO	Upstream USB Port 0 D+ data signal. Note: The upstream Port 0 signals can be optionally swapped with the downstream Port 1 signals.
1	Upstream USB D- (Flex Port 0)	FLEX_USBUP_DM	AIO	Upstream USB Port 0 D- data signal. Note: The upstream Port 0 signals can be optionally swapped with the downstream Port 1 signals.
1	Downstream USB D+ (Swap Port 1)	SWAP_USBDN1_DP	AIO	Downstream USB Port 1 D+ data signal. Note: The downstream Port 1 signals can be optionally swapped with the upstream Port 0 signals.
	Port 1 D+ Disable Configuration Strap	PRT_DIS_P1	IS	This strap is used in conjunction with <u>PRT_DIS_M1</u> to disable USB Port 1. 0 = Port 1 D+ Enabled 1 = Port 1 D+ Disabled Note: Both <u>PRT_DIS_P1</u> and <u>PRT_DIS_M1</u> must be tied to VDD33 at reset to disable the associated port. See Note 3-3 for more information on configuration straps.

TABLE 3-1: PIN DESCRIPTIONS (CONTINUED)

Num Pins	Name	Symbol	Buffer Type	Description
1	Downstream USB D- (Swap Port 1)	SWAP_USBDN1_DM	AIO	Downstream USB Port 1 D- data signal. Note: The downstream Port 1 signals can be optionally swapped with the upstream Port 0 signals.
	Port 1 D- Disable Configuration Strap	<u>PRT_DIS_M1</u>	IS	This strap is used in conjunction with <u>PRT_DIS_P1</u> to disable USB Port 1. 0 = Port 1 D- Enabled 1 = Port 1 D- Disabled Note: Both <u>PRT_DIS_P1</u> and <u>PRT_DIS_M1</u> must be tied to VDD33 at reset to disable the associated port. See Note 3-3 for more information on configuration straps.
1	Downstream USB D+ (Port 2)	USBDN2_DP	AIO	Downstream USB Port 2 D+ data signal.
	Port 2 D+ Disable Configuration Strap	<u>PRT_DIS_P2</u>	IS	This strap is used in conjunction with <u>PRT_DIS_M2</u> to disable USB Port 2. 0 = Port 2 D+ Enabled 1 = Port 2 D+ Disabled Note: Both <u>PRT_DIS_P2</u> and <u>PRT_DIS_M2</u> must be tied to VDD33 at reset to disable the associated port. See Note 3-3 for more information on configuration straps.
1	Downstream USB D- (Port 2)	USBDN2_DM	AIO	Downstream USB Port 2 D- data signal.
	Port 2 D- Disable Configuration Strap	<u>PRT_DIS_M2</u>	IS	This strap is used in conjunction with <u>PRT_DIS_P2</u> to disable USB Port 2. 0 = Port 2 D- Enabled 1 = Port 2 D- Disabled Note: Both <u>PRT_DIS_P2</u> and <u>PRT_DIS_M2</u> must be tied to VDD33 at reset to disable the associated port. See Note 3-3 for more information on configuration straps.
1	Downstream USB D+ (Port 3)	USBDN3_DP	AIO	Downstream USB Port 3 D+ data signal.
	Port 3 D+ Disable Configuration Strap	<u>PRT_DIS_P3</u>	IS	This strap is used in conjunction with <u>PRT_DIS_M3</u> to disable USB Port 3. 0 = Port 3 D+ Enabled 1 = Port 3 D+ Disabled Note: Both <u>PRT_DIS_P3</u> and <u>PRT_DIS_M3</u> must be tied to VDD33 at reset to disable the associated port. See Note 3-3 for more information on configuration straps.

TABLE 3-1: PIN DESCRIPTIONS (CONTINUED)

Num Pins	Name	Symbol	Buffer Type	Description
1	Downstream USB D- (Port 3)	USBDN3_DM	AIO	Downstream USB Port 3 D- data signal.
	Port 3 D- Disable Configuration Strap	<u>PRT_DIS_M3</u>	IS	This strap is used in conjunction with <u>PRT_DIS_P3</u> to disable USB Port 3. 0 = Port 3 D- Enabled 1 = Port 3 D- Disabled Note: Both <u>PRT_DIS_P3</u> and <u>PRT_DIS_M3</u> must be tied to VDD33 at reset to disable the associated port. See Note 3-3 for more information on configuration straps.
1	Downstream USB D+ (Port 4)	USBDN4_DP	AIO	Downstream USB Port 4 D+ data signal.
	Port 4 D+ Disable Configuration Strap	<u>PRT_DIS_P4</u>	IS	This strap is used in conjunction with <u>PRT_DIS_M4</u> to disable USB Port 4. 0 = Port 4 D+ Enabled 1 = Port 4 D+ Disabled Note: Both <u>PRT_DIS_P4</u> and <u>PRT_DIS_M4</u> must be tied to VDD33 at reset to disable the associated port. See Note 3-3 for more information on configuration straps.
1	Downstream USB D- (Port 4)	USBDN4_DM	AIO	Downstream USB Port 4 D- data signal.
	Port 4 D- Disable Configuration Strap	<u>PRT_DIS_M4</u>	IS	This strap is used in conjunction with <u>PRT_DIS_P4</u> to disable USB Port 4. 0 = Port 4 D- Enabled 1 = Port 4 D- Disabled Note: Both <u>PRT_DIS_P4</u> and <u>PRT_DIS_M4</u> must be tied to VDD33 at reset to disable the associated port. See Note 3-3 for more information on configuration straps.
I²C/SMBUS INTERFACE				
1	I ² C Serial Clock Input	SCL	I_SMB	I ² C serial clock input
	SMBus Clock	SMBCLK	I_SMB	SMBus serial clock input
	Configuration Select 0 Configuration Strap	<u>CFG_SEL0</u>	I_SMB	This strap is used in conjunction with <u>CFG_SEL1</u> to set the hub configuration method. Refer to Section 6.3.2, "Configuration Select (CFG_SEL[1:0])", on page 24 for additional information. See Note 3-3 for more information on configuration straps.

TABLE 3-1: PIN DESCRIPTIONS (CONTINUED)

Num Pins	Name	Symbol	Buffer Type	Description
1	I ² C Serial Data	SDA	IS/OD8	I ² C bidirectional serial data
	SMBus Serial Data	SMBDATA	IS/OD8	SMBus bidirectional serial data
	Non-Removable Device 1 Configuration Strap	<u>NON_REM1</u> (Note 3-2)	IS	This strap is used in conjunction with <u>NON_REM0</u> to configure the downstream ports as non-removable devices. Refer to Section 6.3.1, "Non-Removable Device (NON_REM[1:0])" , on page 24 for additional information. See Note 3-3 for more information on configuration straps.
MISC.				
1	Port 1 Over-Current Sense Input	OCS1_N	IS (PU)	This active-low signal is input from an external current monitor to indicate an over-current condition on USB Port 1.
1	Port 2 Over-Current Sense Input	OCS2_N	IS (PU)	This active-low signal is input from an external current monitor to indicate an over-current condition on USB Port 2.
1	Port 3 Over-Current Sense Input	OCS3_N	IS (PU)	This active-low signal is input from an external current monitor to indicate an over-current condition on USB Port 3.
1	Port 4 Over-Current Sense Input	OCS4_N	IS (PU)	This active-low signal is input from an external current monitor to indicate an over-current condition on USB Port 4.
1	General Purpose I/O 0	GPIO0	IS/O8	General purpose I/O 0
1	System Reset Input	RESET_N	I_RST	This active-low signal allows external hardware to reset the device. Note: The active-low pulse must be at least 5 μ s wide. Refer to Section 8.3.2, "External Chip Reset (RESET_N)" , on page 31 for additional information.
1	Crystal Input	XTAL1	ICLK	External 24 MHz crystal input
	Reference Clock Input	REFCLK	ICLK	Reference clock input. The device may be alternatively driven by a single-ended clock oscillator. When this method is used, XTAL2 should be left unconnected.
1	Crystal Output	XTAL2	OCLK	External 24 MHz crystal output
1	External USB Transceiver Bias Resistor	RBIAS	AI	A 12.0k Ω (+/- 1%) resistor is attached from ground to this pin to set the transceiver's internal bias settings.

TABLE 3-1: PIN DESCRIPTIONS (CONTINUED)

Num Pins	Name	Symbol	Buffer Type	Description
1	Detect Upstream VBUS Power	VBUS_DET	IS	Detects state of upstream bus power. When designing a detachable hub, this pin must be connected to the VBUS power pin of the upstream USB port through a resistor divider (50kΩ by 100kΩ) to provide 3.3V. For self-powered applications with a permanently attached host, this pin must be connected to either 3.3V or 5.0V through a resistor divider to provide 3.3V. In embedded applications, VBUS_DET may be controlled (toggled) when the host desires to renegotiate a connection without requiring a full reset of the device.
1	Remote Wakeup Indicator	SUSP_IND	OD8	Configurable sideband signal used to indicate Suspend status (default) or Remote Wakeup events to the Host. Suspend Indicator (default configuration): 0 = Unconfigured, or configured and in USB suspend mode 1 = Device is configured and is active (i.e., not in suspend) For Remote Wakeup Indicator mode: Refer to Section 8.5, "Remote Wakeup Indicator (SUSP_IND)," on page 32. Refer to Section 6.3.1, "Non-Removable Device (NON_REM[1:0])," on page 24 for information on LED polarity when using this signal.
	Local Power Detect	LOCAL_PWR	IS	Detects the availability of a local self-power source. 0 = Self/local power source is NOT available. (i.e., device must obtain all power from upstream USB VBUS) 1 = Self/local power source is available See Note 3-1 for more information on this pin.
	Non-Removable Device 0 Configuration Strap	<u>NON_REM0</u> (Note 3-2)	IS	This strap is used in conjunction with <u>NON_REM1</u> to configure the downstream ports as non-removable devices. Refer to Section 6.3.1, "Non-Removable Device (NON_REM[1:0])," on page 24 for additional information. See Note 3-3 for more information on configuration straps.

TABLE 3-1: PIN DESCRIPTIONS (CONTINUED)

Num Pins	Name	Symbol	Buffer Type	Description
1	High Speed Indicator	HS_IND	O8	Indicates a high speed connection on the upstream port. The active state of the LED will be determined as follows: If CFG_SEL1 = 0, HS_IND is active high. If CFG_SEL1 = 1, HS_IND is active low. Asserted = hub is connected at high speed Negated = Hub is connected at full speed
	Configuration Select 1 Configuration Strap	<u>CFG_SEL1</u>	IS	This strap is used in conjunction with <u>CFG_SEL0</u> to set the hub configuration method. Refer to Section 6.3.2, "Configuration Select (CFG_SEL[1:0])" on page 24 for additional information. See Note 3-3 for more information on configuration straps.
1	Port 1 Power Output	P RTPWR1	O8	Enables power to a downstream USB device attached to Port 1. 0 = Power disabled on downstream Port 1 1 = Power enabled on downstream Port 1
	Port 1 Control	P RTCTL1	OD8/IS (PU)	When configured as P RTCTL1, this pin functions as both the Port 1 power enable output (P RTPWR1) and the Port 1 over-current sense input (OCS1_N). Refer to the P RTPWR1 and OCS1_N descriptions for additional information.
	Port 1 Battery Charging Configuration Strap	<u>BC_EN1</u>	IS	This strap is used to indicate support of the battery charging protocol on Port 1. Enabling battery charging support allows a device on the port to draw currents per the USB battery charging specification. 0 = Battery charging is not supported on Port 1 1 = Battery charging is supported on Port 1 See Note 3-3 for more information on configuration straps.
1	Port 2 Power Output	P RTPWR2	O8	Enables power to a downstream USB device attached to Port 2. 0 = Power disabled on downstream Port 2 1 = Power enabled on downstream Port 2
	Port 2 Control	P RTCTL2	OD8/IS (PU)	When configured as P RTCTL2, this pin functions as both the Port 2 power enable output (P RTPWR2) and the Port 2 over-current sense input (OCS2_N). Refer to the P RTPWR2 and OCS2_N descriptions for additional information.
	Port 2 Battery Charging Configuration Strap	<u>BC_EN2</u>	IS	This strap is used to indicate support of the battery charging protocol on Port 2. Enabling battery charging support allows a device on the port to draw currents per the USB battery charging specification. 0 = Battery charging is not supported on Port 2 1 = Battery charging is supported on Port 2 See Note 3-3 for more information on configuration straps.

TABLE 3-1: PIN DESCRIPTIONS (CONTINUED)

Num Pins	Name	Symbol	Buffer Type	Description
1	Port 3 Power Output	P RTPWR3	O8	Enables power to a downstream USB device attached to Port 3. 0 = Power disabled on downstream Port 3 1 = Power enabled on downstream Port 3
	Port 3 Control	P RTCTL3	OD8/IS (PU)	When configured as P RTCTL3, this pin functions as both the Port 3 power enable output (P RTPWR3) and the Port 3 over-current sense input (OCS3_N). Refer to the P RTPWR3 and OCS3_N descriptions for additional information.
	Port 3 Battery Charging Configuration Strap	<u>BC_EN3</u>	IS	This strap is used to indicate support of the battery charging protocol on Port 3. Enabling battery charging support allows a device on the port to draw currents per the USB battery charging specification. 0 = Battery charging is not supported on Port 3 1 = Battery charging is supported on Port 3 See Note 3-3 for more information on configuration straps.
1	Port 4 Power Output	P RTPWR4	O8	Enables power to a downstream USB device attached to Port 4. 0 = Power disabled on downstream Port 4 1 = Power enabled on downstream Port 4
	Port 4 Control	P RTCTL4	OD8/IS (PU)	When configured as P RTCTL4, this pin functions as both the Port 4 power enable output (P RTPWR4) and the Port 4 over-current sense input (OCS4_N). Refer to the P RTPWR4 and OCS4_N descriptions for additional information.
	Port 4 Battery Charging Configuration Strap	<u>BC_EN4</u>	IS	This strap is used to indicate support of the battery charging protocol on Port 4. Enabling battery charging support allows a device on the port to draw currents per the USB battery charging specification. 0 = Battery charging is not supported on Port 4 1 = Battery charging is supported on Port 4 See Note 3-3 for more information on configuration straps.
1	No Connect	NC	-	These pins must be left floating for normal device operation.
POWER				
1	Battery Power Supply Input	VBAT	P	Battery power supply input. When VBAT is connected directly to a +3.3V supply from the system, the internal +3.3V regulator runs in dropout and regulator power consumption is eliminated. A 4.7 μ F (<1 Ω ESR) capacitor to ground is required for regulator stability. The capacitor should be placed as close as possible to the device. Refer to Section 4.0, "Power Connections," on page 17 for power connection information.
3	+3.3V Analog Power Supply	VDDA33	P	+3.3V analog power supply. Refer to Section 4.0, "Power Connections," on page 17 for power connection information.
2	+3.3V Power Supply	VDD33	P	+3.3V power supply. These pins must be connected to VDDA33. Refer to Section 4.0, "Power Connections," on page 17 for power connection information.

TABLE 3-1: PIN DESCRIPTIONS (CONTINUED)

Num Pins	Name	Symbol	Buffer Type	Description
1	+1.2V Core Power Supply	VDDCR12	P	+1.2V core power supply. A 1.0 μ F (<1 Ω ESR) capacitor to ground is required for regulator stability. The capacitor should be placed as close as possible to the device. Refer to Section 4.0, "Power Connections," on page 17 for power connection information.
Exposed Pad on package bottom (Figure 3-1)	Ground	VSS	P	Common ground. This exposed pad must be connected to the ground plane with a via array.

Note 3-1 The LOCAL_PWR pin is sampled during the configuration state, immediately after negation of reset, to determine whether the device is bus-powered or self-powered. When configuration is complete, the latched value will not change until the next reset assertion. To enable dynamic local power switching, the DYNAMIC_POWER register at location 0x4134 must be programmed with 0x41. If dynamic power switching is not required, the DYNAMIC_POWER register should be left at the default value of 0xC1. Programming may be performed through the SMBus interface, or permanently via OTP. Refer to the Protouch MPT User Manual for additional information.

Note 3-2 If using the local power detect function (LOCAL_PWR pin), the NON_REM[1:0] configuration straps cannot be used to configure the non-removable state of the USB ports. In this case, the non-removable state of the ports must be configured in internal device registers via the Protouch tool or SMBus.

Note 3-3 Configuration strap values are latched on Power-On Reset (POR) and the rising edge of RESET_N (external chip reset). Configuration straps are identified by an underlined symbol name. Signals that function as configuration straps must be augmented with an external resistor when connected to a load. Refer to [Section 6.3, "Device Configuration Straps,"](#) on page 24 for additional information.

3.2 Pin Assignments

TABLE 3-2: 36-SQFN PACKAGE PIN ASSIGNMENTS

Pin Num	Pin Name	Pin Num	Pin Name
1	SWAP_USBDN1_DM/PRT_DIS_M1	19	OCS3_N
2	SWAP_USBDN1_DP/PRT_DIS_P1	20	PRT_PWR4/PRT_CTL4/BC_EN4
3	USBDN2_DM/PRT_DIS_M2	21	OCS4_N
4	USBDN2_DP/PRT_DIS_P2	22	SDA/SMB_DATA/NON_REM1
5	NC	23	VDD33
6	USBDN3_DM/PRT_DIS_M3	24	SCL/SMB_CLK/CFG_SEL0
7	USBDN3_DP/PRT_DIS_P3	25	HS_IND/CFG_SEL1
8	USBDN4_DM/PRT_DIS_M4	26	RESET_N
9	USBDN4_DP/PRT_DIS_P4	27	VBUS_DET
10	VDDA33	28	SUSP_IND/LOCAL_PWR/NON_REM0
11	GPIO0	29	VDDA33
12	PRT_PWR1/PRT_CTL1/BC_EN1	30	FLEX_USBUP_DM
13	OCS1_N	31	FLEX_USBUP_DP
14	VDDCR12	32	XTAL2
15	VDD33	33	XTAL1/REFCLK
16	PRT_PWR2/PRT_CTL2/BC_EN2	34	VDDA33
17	OCS2_N	35	RBIAS
18	PRT_PWR3/PRT_CTL3/BC_EN3	36	VBAT

3.3 Buffer Type Descriptions

TABLE 3-3: BUFFER TYPES

Buffer Type	Description
IS	Schmitt-triggered input
I_RST	Reset Input
I_SMB	I ² C/SMBus Clock Input
O8	Output with 8 mA sink and 8 mA source
OD8	Open-drain output with 8 mA sink
OD12	Open-drain output with 12 mA sink
PU	50 μ A (typical) internal pull-up. Unless otherwise noted in the pin description, internal pull-ups are always enabled. Note: Internal pull-up resistors prevent unconnected inputs from floating. Do not rely on internal resistors to drive signals external to the device. When connected to a load that must be pulled high, an external resistor must be added.
PD	50 μ A (typical) internal pull-down. Unless otherwise noted in the pin description, internal pull-downs are always enabled. Note: Internal pull-down resistors prevent unconnected inputs from floating. Do not rely on internal resistors to drive signals external to the device. When connected to a load that must be pulled low, an external resistor must be added.
AIO	Analog bi-directional
ICLK	Crystal oscillator input pin
OCLK	Crystal oscillator output pin
P	Power pin

4.0 POWER CONNECTIONS

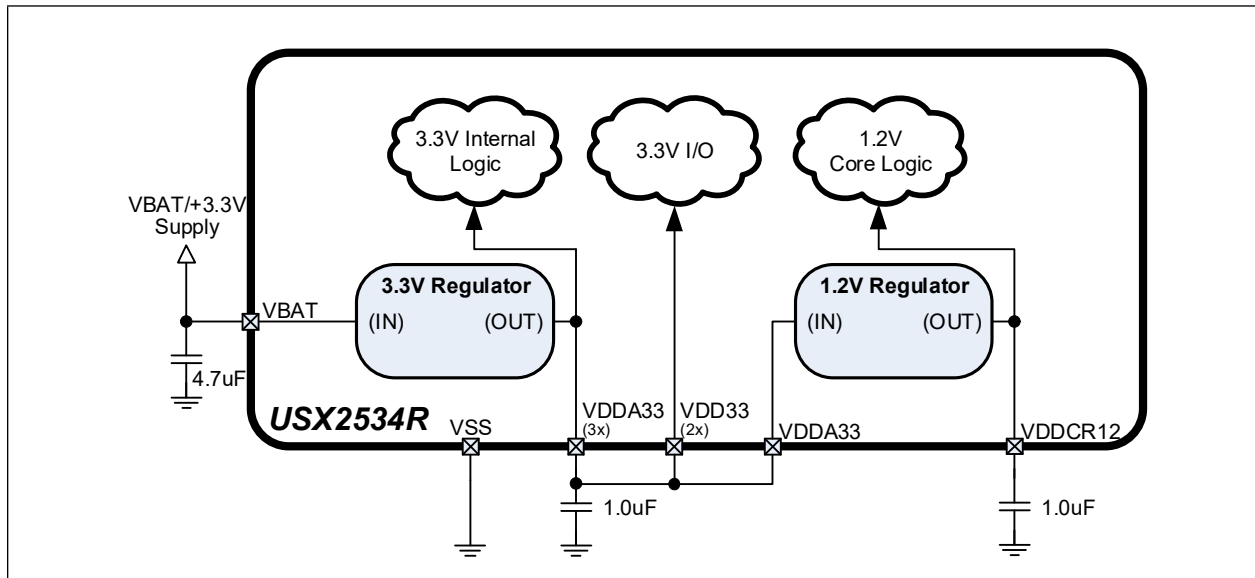
4.1 Integrated Power Regulators

The integrated 3.3V and 1.2V power regulators allow the device to be supplied via a single 3.3V external power supply. The regulators are controlled by RESET_N. When RESET_N is brought high, the 3.3V regulator will turn on. When RESET_N is brought low the 3.3V regulator will turn off.

4.2 Power Connection Diagram

Figure 4-1 illustrates the power connections for the USX2534R.

FIGURE 4-1: POWER CONNECTIONS



5.0 MODES OF OPERATION

The device provides two main modes of operation: Standby Mode and Hub Mode. The operating mode of the device is selected by setting values on primary inputs according to the table below.

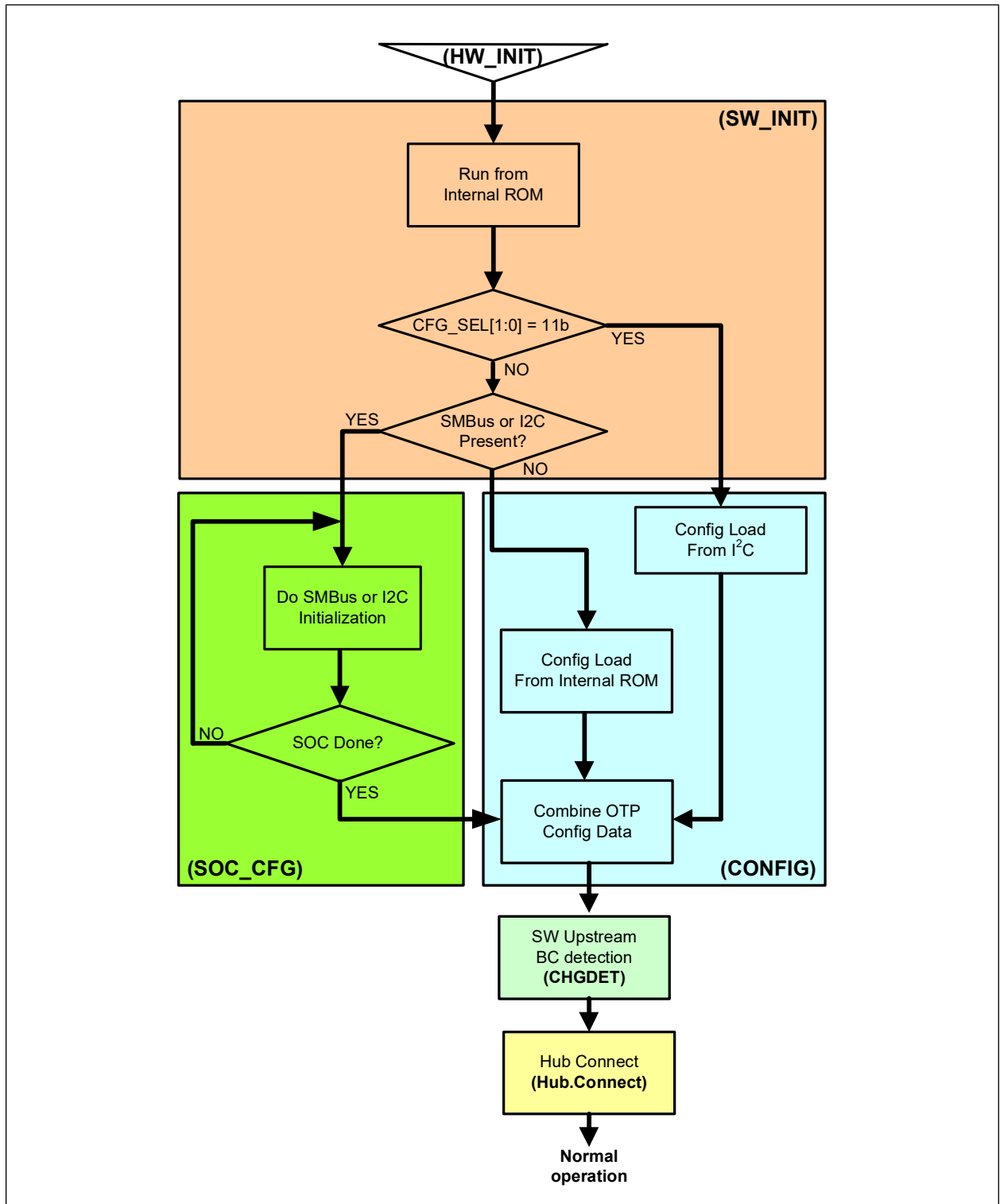
TABLE 5-1: CONTROLLING MODES OF OPERATION

RESET_N Input	Resulting Mode	Summary
0	Standby	Lowest Power Mode: No functions are active other than monitoring the RESET_N input. All port interfaces are high impedance. All regulators are powered off.
1	Hub	Full Feature Mode: Device operates as a configurable USB hub with battery charger detection. Power consumption is based on the number of active ports, their speed, and amount of data transferred.

Note: Refer to [Section 8.3.2, "External Chip Reset \(RESET_N\)," on page 31](#) for additional information on RESET_N.

The flowchart in [Figure 5-1](#) shows the modes of operation. It also shows how the device traverses through the Hub mode stages (shown in bold.) The flow of control is dictated by control register bits shown in italics as well as other events such as availability of a reference clock. The remaining sections in this chapter provide more detail on each stage and mode of operation.

FIGURE 5-1: HUB OPERATIONAL MODE FLOWCHART



5.1 Boot Sequence

5.1.1 STANDBY MODE

If the external hardware reset is asserted, the hub will be in Standby Mode. This mode provides a very low power state for maximum power efficiency when no signaling is required. This is the lowest power state. In Standby Mode all internal regulators are powered off, the PLL is not running, and core logic is powered down in order to minimize power consumption. Because core logic is powered off, no configuration settings are retained in this mode and must be re-initialized after RESET_N is negated high.

5.1.2 HARDWARE INITIALIZATION STAGE (HW_INIT)

The first stage is the initialization stage and occurs on the negation of RESET_N. In this stage the 1.2V regulator is enabled and stabilizes, internal logic is reset, and the PLL locks if a valid REFCLK is supplied. Configuration registers are initialized to their default state and strap input values are latched. The device will complete initialization and automatically enter the next stage. Because the digital logic within the device is not yet stable, no communication with the device using the SMBus is possible. Configuration registers are initialized to their default state.

If there is a REFCLK present, the next state is SW_INIT.

5.1.3 SOFTWARE INITIALIZATION STAGE (SW_INIT)

Once the hardware is initialized, the firmware can begin to execute from the internal ROM. The firmware checks the CFG_SEL[1:0] configuration strap values to determine if it is configured for I²C Host loading. If so, the configuration is loaded from an external I²C ROM in the device's CONFIG state.

For all other configurations, the firmware checks for the presence of an external I²C/SMBus. It does this by asserting two pull down resistors on the data and clock lines of the bus. The pull downs are typically 50Kohm. If there are 10Kohm pull-ups present, the device becomes aware of the presence of an external SMBus/I²C bus. If a bus is detected, the firmware transitions to the SOC_CFG state.

5.1.4 SOC CONFIGURATION STAGE (SOC_CFG)

In this stage, the SOC may modify any of the default configuration settings specified in the integrated ROM such as USB device descriptors, or port electrical settings, and control features such as upstream battery charging detection.

There is no time limit. In this stage the firmware will wait indefinitely for the SMBus/I²C configuration. When the SOC has completed configuring the device, it must write to register 0xFF to end the configuration.

5.1.5 CONFIGURATION STAGE (CONFIG)

Once the SOC has indicated that it is done with configuration, then all the configuration data is combined. The default data, the SOC configuration data, the OTP data are all combined in the firmware and device is programmed.

After the device is fully configured, it will go idle and then into suspend if there is no VBUS or Hub.Connect present. Once VBUS is present, and upstream battery charging is enabled, the device will transition to the Battery Charger Detection Stage (CHGDET). If VBUS is present, and upstream battery charging is not enabled, the device will transition to the Connect (Hub.Connect) stage.

5.1.6 BATTERY CHARGER DETECTION STAGE (CHGDET)

After configuration, if enabled, the device enters the Battery Charger Detection Stage. If the battery charger detection feature was disabled during the CONFIG stage, the device will immediately transition to the Hub Connect (Hub.Connect) stage. If the battery charger detection feature remains enabled, the battery charger detection sequence is started automatically.

If the charger detection remains enabled, the device will transition to the Hub.Connect stage if using the hardware detection mechanism.

5.1.7 HUB CONNECT STAGE (HUB.CONNECT)

Once the CHGDET stage is completed, the device enters the Hub.Connect stage.

5.1.8 NORMAL MODE

Lastly the SOC enters the Normal Mode of operation. In this stage, full USB operation is supported under control of the USB Host on the upstream port. The device will remain in the normal mode until the operating mode is changed by the system.

If RESET_N is asserted low, then Standby Mode is entered. The device may then be placed into any of the designated Hub stages. Asserting the soft disconnect on the upstream port will cause the Hub to return to the Hub.Connect stage until the soft disconnect is negated.

To save power, communication over the SMBus is not supported while in USB Suspend. The system can prevent the device from going to sleep by asserting the ClkSusp control bit of the Configure Portable Hub Register anytime before entering USB Suspend. While the device is kept awake during USB Suspend, it will provide the SMBus functionality at the expense of not meeting USB requirements for average suspend current consumption.

6.0 DEVICE CONFIGURATION

The device supports a large number of features (some mutually exclusive), and must be configured in order to correctly function when attached to a USB host controller. The hub can be configured either internally or externally depending on the implemented interface.

Microchip provides a comprehensive software programming tool, Pro-Touch, for configuring the USX2534R functions, registers and OTP memory. All configuration is to be performed via the Pro-Touch programming tool. For additional information on the Pro-Touch programming tool, contact your local Microchip sales representative.

6.1 Configuration Method Selection

The `CFG_SEL[1:0]` configuration straps and the SDA pin are used to determine the hub configuration method, as shown in [Table 6-1](#). The software reads the SDA pin and the `CFG_SEL[1:0]` bits and configures the system appropriately.

TABLE 6-1: HUB CONFIGURATION SELECTION

SDA	CFG_SEL1	CFG_SEL0	Description
X	0	0	Configuration is based on the configuration strap options and internal OTP settings. This configuration sets the device Self powered operation.
0	0	1	Invalid
X	1	0	Configuration based on the configuration strap options and internal OTP settings. This configuration sets the device for Bus powered operation.
1	1	1	Firmware performs a configuration load from 2-wire (I ² C) EEPROM. The device does not perform an SMBus Host detection. Configuration is controlled by EEPROM values and OTP settings. Strap options are disabled.
1	0	1	Firmware must wait for configuration from an SMBus Host. Configuration is controlled by SMBus Host and OTP settings. Strap options are disabled.

Note: Refer to [Section 7.0, "Device Interfaces," on page 26](#) for detailed information on each device configuration interface.

6.2 Customer Accessible Functions

The following USB or SMBus accessible functions are available to the customer via the Pro-Touch Programming Tool.

Note: For additional programming details, refer to the Pro-Touch Programming Tool User Manual.

6.2.1 USB ACCESSIBLE FUNCTIONS

6.2.1.1 VSM commands over USB

By default, Vendor Specific Messaging (VSM) commands to the hub are enabled. The supported commands are:

- Enable Embedded Controller
- Disable Embedded Controller
- Enable Special Resume
- Disable Special Resume
- Reset Hub

6.2.1.2 I²C Host Access over USB

Access to I²C devices is performed as a pass-through operation from the USB Host. The device firmware has no knowledge of the operation of the attached I²C device. The supported commands are:

- Enable I²C pass through mode
- Disable I²C pass through mode

- I²C write
- I²C read
- Send I²C start
- Send I²C stop

6.2.1.3 OTP Access over USB

The OTP ROM in the device is accessible via the USB bus. All OTP parameters can be modified via the USB Host. The OTP operates in Single Ended mode. The supported commands are:

- Enable OTP reset
- Set OTP operating mode
- Set OTP read mode
- Program OTP
- Get OTP status
- Program OTP control parameters

6.2.1.4 Battery Charging Access over USB

The Battery charging behavior of the device can be dynamically changed by the USB Host when something other than the preprogrammed or OTP programmed behavior is desired. The supported commands are:

- Enable/Disable battery charging
- Upstream battery charging mode control
- Downstream battery charging mode control
- Battery charging timing parameters
- Download custom battery charging algorithm

6.2.1.5 Other Embedded Controller functions over USB

The following miscellaneous functions may be configured via USB:

- Enable/Disable Embedded controller enumeration
- Program Configuration parameters.
- Program descriptor fields:
 - Language ID
 - Manufacturer string
 - Product string
 - idVendor
 - idProduct
 - bcdDevice

6.2.2 SMBUS ACCESSIBLE FUNCTIONS

6.2.2.1 OTP Access over SMBus

The device's OTP ROM is accessible over SMBus. All OTP parameters can be modified via the SMBus Host. The OTP can be programmed to operate in Single-Ended, Differential, Redundant, or Differential Redundant mode, depending on the level of reliability required. The supported commands are:

- Enable OTP reset
- Set OTP operating mode
- Set OTP read mode
- Program OTP
- Get OTP Status
- Program OTP control parameters

6.2.2.2 Configuration Access over SMBus

The following functions are available over SMBus prior to the hub attaching to the USB host:

- Program Configuration parameters.
- Program descriptor fields:
 - Language ID
 - Manufacturer string
 - Product string
 - idVendor
 - idProduct
 - bcdDevice
- Program Control Register

6.3 Device Configuration Straps

Configuration straps are multi-function pins that are driven as outputs during normal operation. During a [Power-On Reset \(POR\)](#) or an [External Chip Reset \(RESET_N\)](#), these outputs are tri-stated. The high or low state of the signal is latched following de-assertion of the reset and is used to determine the default configuration of a particular feature. Configuration straps are latched as a result of a [Power-On Reset \(POR\)](#) or a [External Chip Reset \(RESET_N\)](#). Configuration strap signals are noted in [Section 3.0, "Pin Descriptions," on page 7](#) and are identified by an underlined symbol name. The following sub-sections detail the various configuration straps.

Configuration straps include internal resistors in order to prevent the signal from floating when unconnected. If a particular configuration strap is connected to a load, an external pull-up or pull-down should be used to augment the internal resistor to ensure that it reaches the required voltage level prior to latching. The internal resistor can also be overridden by the addition of an external resistor.

Note: The system designer must ensure that configuration straps meet the timing requirements specified in [Section 9.6.2, "Reset and Configuration Strap Timing," on page 38](#) and [Section 9.6.1, "Power-On Configuration Strap Valid Timing," on page 38](#). If configuration straps are not at the correct voltage level prior to being latched, the device may capture incorrect strap values. Configuration straps must never be driven as inputs. If required, configuration straps can be augmented, or overridden with external resistors.

6.3.1 NON-REMOVABLE DEVICE (NON_REM[1:0])

The NON_REM[1:0] configuration straps are sampled at RESET_N negation to determine if ports [3:1] contain permanently attached (non-removable) devices as follows. Additionally, because the SUSP_IND indicator functionality is shared with the NON_REM0 configuration strap, the active state of the LED connected to SUSP_IND will be determined as follows:

TABLE 6-2: NON_REM[1:0] CONFIGURATION DEFINITIONS

<u>NON_REM[1:0]</u>	Definition
'00'	All USB ports removable, SUSP_IND LED active high
'01'	Port 1 is non-removable, SUSP_IND LED active low
'10'	Ports 1 & 2 are non-removable, SUSP_IND LED active high
'11'	Ports 1, 2 & 3 are non-removable, SUSP_IND LED active low

Note: If using the local power detect function (LOCAL_PWR pin), the NON_REM[1:0] configuration straps cannot be used to configure the non-removable state of the USB ports. In this case, the non-removable state of the ports must be configured in internal device registers via the Protouch tool or SMBus.

6.3.2 CONFIGURATION SELECT (CFG_SEL[1:0])

Refer to [Section 6.1, "Configuration Method Selection," on page 22](#) for details on CFG_SEL[1:0].

6.3.3 DOWNSTREAM BATTERY CHARGING ENABLE (BC_EN[4:1])

The battery charging enable configuration straps are used to enable battery charging on the corresponding downstream port. For example, if BC_EN1 is driven high during the configuration strap latching time, downstream port 1 will indicate support of battery charging. Refer to [Section 8.1.2, "Downstream Battery Charging," on page 29](#) for additional information on battery charging.

6.3.4 PORT DISABLE (PRT_DIS_MX/PRT_DIS_PX)

These configuration straps disable the associated USB ports D- and D+ signals, respectively, where “x” is the USB port number. Both the negative “M” and positive “P” port disable configuration straps for a given USB port must be tied high at reset to disable the associated port.

TABLE 6-3: PRT_DIS_MX/PRT_DIS_PX CONFIGURATION DEFINITIONS

<u>PRT_DIS_Mx/PRT_DIS_Px</u>	Definition
'0'	Port x D-/D+ Signal is Enabled (Default)
'1'	Port x D-/D+ Signal is Disabled

7.0 DEVICE INTERFACES

The USX2534R provides multiple interfaces for configuration and external memory access. This chapter details the various device interfaces and their usage.

Note: For information on device configuration, refer to [Section 6.0, "Device Configuration," on page 22](#).

7.1 I²C Host Interface

The I²C host interface implements a subset of the I²C Host Specification (Please refer to the *Philips Semiconductor Standard I²C-Bus Specification* for details on I²C bus protocols). The device's I²C host interface is designed to attach to a single "dedicated" I²C EEPROM for loading configuration data and conforms to the Standard-Mode I²C Specification (100 kbit/s transfer rate and 7-bit addressing) for protocol and electrical compatibility. The device acts as the host and generates the serial clock SCL, controls the bus access (determines which device acts as the transmitter and which device acts as the receiver), and generates the START and STOP conditions.

Note:

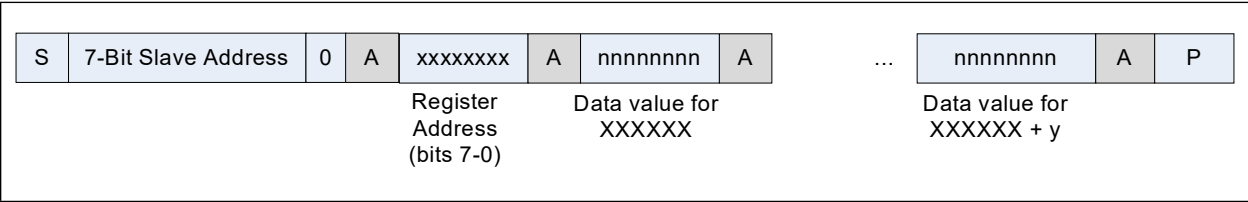
- Extensions to the I²C Specification are not supported.
- All device configuration must be performed via the Pro-Touch Programming Tool. For additional information on the Pro-Touch programming tool, contact your local sales representative.

7.1.1 I²C MESSAGE FORMAT

7.1.1.1 Sequential Access Writes

The I²C interface supports sequential writing of the device's register address space. This mode is useful for configuring contiguous blocks of registers. [Figure 7-1](#) shows the format of the sequential write operation. Where color is visible in the figure, blue indicates signaling from the I²C host, and gray indicates signaling from the device.

FIGURE 7-1: I²C SEQUENTIAL ACCESS WRITE FORMAT



In this operation, following the 7-bit device address, the 8-bit register address is written indicating the start address for sequential write operation. Every subsequent access is a data write to a data register, where the register address increments after each access and an ACK from the device occurs. Sequential write access is terminated by a Stop condition.

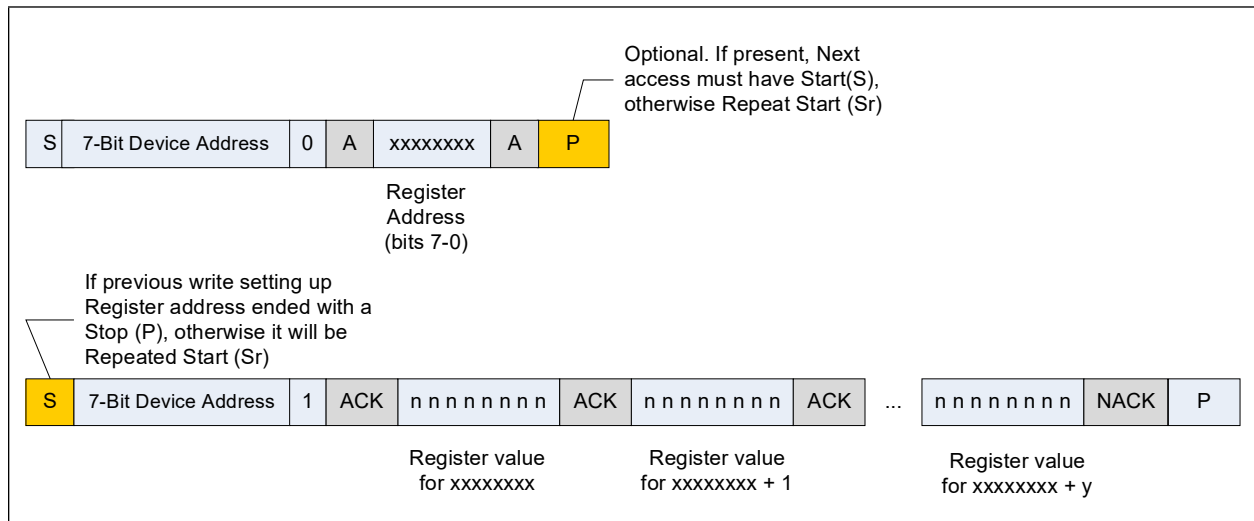
7.1.1.2 Sequential Access Reads

The I²C interface supports direct reading of the device registers. In order to read one or more register addresses, the starting address must be set by using a write sequence followed by a read. The read register interface supports auto-increment mode. The host must send a NACK instead of an ACK when the last byte has been transferred.

In this operation, following the 7-bit device address, the 8-bit register address is written indicating the start address for the subsequent sequential read operation. In the read sequence, every data access is a data read from a data register where the register address increments after each access. The write sequence can end with optional Stop (P). If so, the read sequence must begin with a Start (S). Otherwise, the read sequence must start with a Repeated Start (Sr).

Figure 7-2 shows the format of the read operation. Where color is visible in the figure, blue and gold indicate signaling from the I²C host, and gray indicates signaling from the device.

FIGURE 7-2: I²C SEQUENTIAL ACCESS READ FORMAT



7.1.2 PULL-UP RESISTORS FOR I²C

The circuit board designer is required to place external pull-up resistors (10 k Ω recommended) on the SDA & SCL signals (per SMBus 1.0 Specification) to Vcc in order to assure proper operation.

7.2 SMBus Device Interface

The USX2534R includes an integrated SMBus device interface, which can be used to access internal device run time registers or program the internal OTP memory. SMBus detection is accomplished by detection of pull-up resistors (10 k Ω recommended) on both the SMBDATA and SMBCLK signals. To disable the SMBus, a pull-down resistor of 10 k Ω must be applied to SMBDATA. The SMBus interface can be used to configure the device as detailed in [Section 6.1, "Configuration Method Selection," on page 22](#).

Note: All device configuration must be performed via the Pro-Touch Programming Tool. For additional information on the Pro-Touch programming tool, contact your local Microchip sales representative.

8.0 FUNCTIONAL DESCRIPTIONS

This chapter provides additional functional descriptions of key device features.

8.1 Battery Charger Detection & Charging

The USX2534R supports both upstream battery charger detection and downstream battery charging. The integrated battery charger detection circuitry supports the USB-IF Battery Charging (BC1.2) detection method and most Apple devices. These circuits are used to detect the attachment and type of a USB charger and provide an interrupt output to indicate charger information is available to be read from the device's status registers via the serial interface. The USX-2534R provides the battery charging handshake and supports the following USB-IF BC1.2 charging profiles:

- DCP: Dedicated Charging Port (Power brick with no data)
- CDP: Charging Downstream Port (1.5A with data)
- SDP: Standard Downstream Port (0.5A with data)
- Custom profiles loaded via SMBus or OTP

The following sub-sections detail the upstream battery charger detection and downstream battery charging features.

8.1.1 UPSTREAM BATTERY CHARGER DETECTION

Battery charger detection is available on the upstream facing port. The detection sequence is intended to identify chargers which conform to the Chinese battery charger specification, chargers which conform to the USB-IF Battery Charger Specification 1.2, and most Apple devices.

In order to detect the charger, the device applies and monitors voltages on the upstream DP and DM pins. If a voltage within the specified range is detected, the device will be updated to reflect the proper status.

The device includes the circuitry required to implement battery charging detection using the Battery Charging Specification. When enabled, the device will automatically perform charger detection upon entering the Hub.ChgDet stage in Hub Mode. The device includes a state machine to provide the detection of the USB chargers listed in the table below.

TABLE 8-1: CHARGERS COMPATIBLE WITH UPSTREAM DETECTION

USB Attach TypeE	DP/DM Profile	Charger Type
DCP (Dedicated Charging Port)	Shorted < 200ohm	001
CDP (Charging Downstream Port)	VDP reflected to VDM	010 (EnhancedChrgDet = 1)
SDP (Standard Downstream Port) USB Host or downstream hub port	15Kohm pull-down on DP and DM	011
Apple Low Current Charger	Apple	100
Apple High Current Charger	Apple	101
Apple Super High Current Charger	DP=2.7V DM=2.0V	110
Apple Charger Low Current Charger (500mA)	DP=2.0V DM=2.0V	100
Apple Charger High Current Charger (1000mA)	DP=2.0V DM=2.7V	101

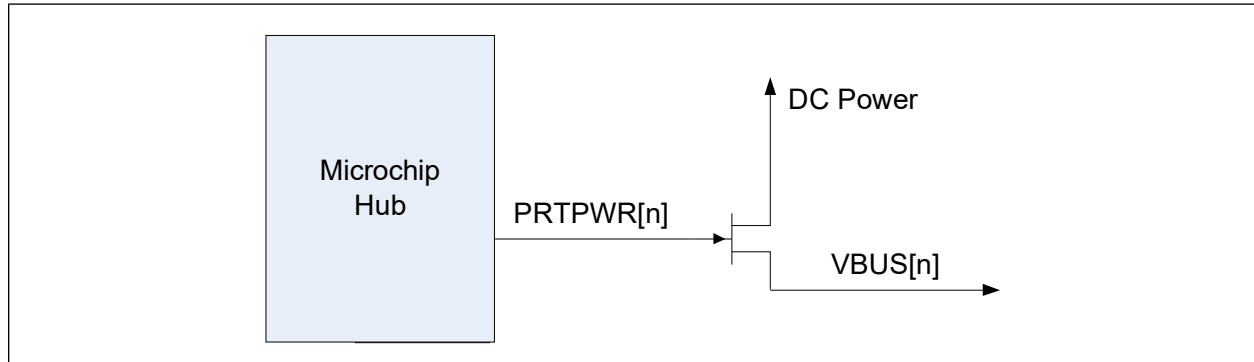
If a custom charger detection algorithm is desired, the SMBus registers can also be used to control the charger detection block to implement a custom charger detection algorithm. In order to avoid negative interactions with automatic battery charger detection or normal hub operation, the user should only attempt Custom battery charger detection during the Hub.Config stage or Hub.Connect stage. No logic is implemented to disable custom detection at other times - it is up to the user software to observe this restriction.

There is a possibility that the system is not running the reference clock when battery charger detection is required (for example if the battery is dead or missing). During the Hub.WaitRefClk stage the battery charger detection sequence can be configured to be followed regardless of the activity of REFCLK by relying on the operation of the internal oscillator.

8.1.2 DOWNSTREAM BATTERY CHARGING

The device can be configured by an OEM to have any of the downstream ports to support battery charging. The Hub's role in battery charging is to provide an acknowledge to a device's query as to if the hub system supports USB battery charging. The hub silicon does not provide any current or power FETs or any additional circuitry to actually charge the device. Those components must be provided as externally by the OEM.

FIGURE 8-1: BATTERY CHARGING EXTERNAL POWER SUPPLY



If the OEM provides an external supply capable of supplying current per the battery charging specification, the hub can be configured to indicate the presence of such a supply to the device. This indication, via the P RTPWR[1:4] output pins, is on a per/port basis. For example, the OEM can configure two ports to support battery charging through high current power FET's and leave the other two ports as standard USB ports.

8.1.2.1 Downstream Battery Charging Modes

In the terminology of the USB Battery Charging Specification, if a port is configured to support battery charging, the downstream port is considered a CDP (Charging Downstream Port) if connected to a USB host, or a DCP (Dedicated Charging Port) if not connected to a USB host. If the port is not configured to support battery charging, the port is considered an SDP (Standard Downstream Port). All charging ports have electrical characteristics different from standard non-charging ports.

A downstream port will behave as a CDP, DCP, or SDP depending on the port's configuration and mode of operation. The port will not switch between a CDP/DCP or SDP at any time after initial power-up and configuration. A downstream port can be in one of three modes shown in the table below.

TABLE 8-2: DOWNSTREAM PORT TYPES

USB Attach Type	DP/DM Profile
DCP (Dedicated Charging Port)	Apple charging mode or China Mode (Shorted < 200ohm) or MCHP custom mode
CDP (Charging Downstream Port)	VDP reflected to VDM
SDP (Standard Downstream Port) USB Host or downstream hub port	15Kohm pull-down on DP and DM

8.1.2.2 Downstream Battery Charging Configuration

Configuration of ports to support battery charging is performed via the **BC_EN** configuration straps, USB configuration, SMBus configuration, or OTP. The Battery Charging Enable Register provides per port battery charging configuration. Starting from bit 1, this register enables battery charging for each down stream port when asserted. Bit 1 represents port 1 and so on. Each port with battery charging enabled asserts the corresponding P RTPWR register bit.

8.1.2.3 Downstream Over-Current Management

It is the devices responsibility to manage over-current conditions. Over-Current Sense (OCS) is handled according to the USB specification. For battery charging ports, PRTPWR is driven high (asserted) after hardware initialization. If an OCS event occurs, the PRTPWR is negated. PRTPWR will be negated for all ports in a ganged configuration. Only the respective PRTPWR will be negated in the individual configuration.

If there is an over-current event in DCP mode, the port is turned off for one second and is then re-enabled. If the OCS event persists, the cycle is repeated for a total of three times. If after three attempts, the OCS still persists, the cycle is still repeated, but with a retry interval of ten seconds. This retry persists for indefinitely. The indefinite retry prevents a defective device from permanently disabling the port.

In CDP or SDP mode, the port power and over-current events are controlled by the USB host. The OCS event does not have to be registered. When and if the hub is connected to a host, the host will initialize the hub and enable its port power. If the over current still exists, it will be notified at that point.

8.2 Flex Connect

This feature allows the upstream port to be swapped with downstream physical port 1. Only physical downstream port 1 can be swapped using FlexConnect; However, port remapping allows any logical port (number assignment as seen by a USB host) to be swapped with the upstream port if the application requires it.

While the hub is in the flexed state, the original upstream port ("Port 0") may operate as a downstream facing port. If this is not desired, physical port 1 should be disabled via configuration to ensure that while in the flexed state, physical port 0 does not operate as a downstream facing port.

8.2.1 REGISTER CONTROL (USX2534R DEVICES)

FlexConnect is enabled/disabled via two control bits in the Connect Configuration Register. The FLEXCONNECT configuration bit activates FlexConnect to swap host role with physical port 1, and EN_FLEX_MODE enables the FlexConnect mode, which modifies pin behavior.

The FlexConnect registers may only be modified during the configuration stage of the hub before hub runtime (during SOC_CFG, see [Figure 5-1](#)). The hub must be reset then re-configured to change the state of FlexConnect. FlexConnect cannot be activated dynamically during runtime.

Note: The Condition where EN_FLEX_MODE = 0 and FLEXCONNECT = 1 is not a supported mode of operation.

TABLE 8-3: FLEXCONNECT REGISTER CONTROL OPERATION

Pin	EN_FLEX_MODE = 0 & FLEXCONNECT = 0	EN_FLEX_MODE = 1 & FLEXCONNECT = 0	EN_FLEX_MODE = 1 & FLEXCONNECT = 1
12	PRTPWR1	PRTPWR/OCS1_N Combined Mode (Note 8-1)	Drive High (Logic 1)
13	OCS1_N	Don't Care	VBUS_DET
28	SUSP_IND	Drive Low (Logic 0)	PRTPWR1/OSC1_N
27	VBUS_DET	VBUS_DET	Don't Care

Note 8-1 PRTPWR1/OSC1_N Combined Mode operates as follows: When the downstream port is enabled, this pin is set as an input with an internal pull-up resistor applied. The internal pull-up enables power to the downstream port while the pin monitors for an active low overcurrent signal assertion from an external current monitor on USB port 5. This pin will change to an output and be driven low when the port is disabled by configuration or by the host control.

8.2.2 PIN CONTROL (USX2534RPF DEVICES)

In USX2534RPF devices, pin 11 is configured by default as the FLEX_IN control signal. FLEX_IN operates as shown in [Table 8-4](#).

TABLE 8-4: FLEXCONNECT PIN CONTROL OPERATION

Pin	FLEX_IN = 0 Physical Port 0 is Upstream Port	FLEX_IN = 1 Physical Port 1 is Upstream Port
12	P RTPWR/OCS1_N Combined Mode (Note 8-1)	Drive High (Logic 1)
13	Don't Care	VBUS_DET
28	Drive Low (Logic 0)	P RTPWR1/OSC1_N
27	VBUS_DET	Don't Care

One common configuration option may be to disable physical port 1 via OTP configuration settings such that operation becomes:

- FLEX_IN = 0: Physical Port 0 is the upstream facing port and Physical Port 1 is non-functional.
- FLEX_IN = 1: Physical Port 1 is the upstream facing port and Physical Port 0 becomes non-functional

When FlexConnect is either activated or de-activated, the USX2534RPF device is reset. This creates a potential conflict if the hub device is also being configured via SMBus in the application. When the hub is configured for SMBus configuration, the hub will wait in the configuration state (SCO_CFG) before entering runtime each time FlexConnect is activated/de-activated by toggle state change. When the hub is waiting in the configuration state, the hub must receive the USB Attach command from the SMBus host before it may enter runtime. Hence, it is strongly recommended that system integrators considering USX2534RPF do not use the SMBus configuration channel. If the SMBus configuration channel is required by the application, then it is recommended to use standard USX2534R devices along with register-based FlexConnect control methods.

8.3 Resets

The device has the following chip level reset sources:

- [Power-On Reset \(POR\)](#)
- [External Chip Reset \(RESET_N\)](#)
- [USB Bus Reset](#)

8.3.1 POWER-ON RESET (POR)

A power-on reset occurs whenever power is initially supplied to the device, or if power is removed and reapplied to the device. A timer within the device will assert the internal reset per the specifications listed in [Section 9.6.1, "Power-On Configuration Strap Valid Timing," on page 38](#).

8.3.2 EXTERNAL CHIP RESET (RESET_N)

A valid hardware reset is defined as assertion of RESET_N, after all power supplies are within operating range, per the specifications in [Section 9.6.2, "Reset and Configuration Strap Timing," on page 38](#). While reset is asserted, the device (and its associated external circuitry) enters Standby Mode and consumes minimal current.

Assertion of RESET_N causes the following:

1. The PHY is disabled and the differential pairs will be in a high-impedance state.
2. All transactions immediately terminate; no states are saved.
3. All internal registers return to the default state.
4. The external crystal oscillator is halted.
5. The PLL is halted.

Note: All power supplies must have reached the operating levels mandated in [Section 9.2, "Operating Conditions**," on page 35](#), prior to (or coincident with) the assertion of RESET_N.

8.3.3 USB BUS RESET

In response to the upstream port signaling a reset to the device, the device performs the following:

Note: The device does not propagate the upstream USB reset to downstream devices.

1. Sets default address to 0.
2. Sets configuration to: Unconfigured.
3. Moves device from suspended to active (if suspended).
4. Complies with Section 11.10 of the USB 2.0 Specification for behavior after completion of the reset sequence.

The host then configures the device in accordance with the USB Specification.

8.4 Link Power Management (LPM)

The device supports the L0 (On), L1 (Sleep), and L2 (Suspend) link power management states per the USB 2.0 Link Power Management Addendum. These supported LPM states offer low transitional latencies in the tens of microseconds versus the much longer latencies of the traditional USB suspend/resume in the tens of milliseconds. The supported LPM states are detailed in [Table 8-5](#). For additional information, refer to the USB 2.0 Link Power Management Addendum.

TABLE 8-5: LPM STATE DEFINITIONS

State	Description	Entry/Exit Time to L0
L2	Suspend	Entry: ~3 ms Exit: ~2 ms
L1	Sleep	Entry: ~65 us Exit: ~100 us
L0	Fully Enabled (On)	-

Note: State change timing is approximate and is measured by change in power consumption. System clocks are stopped only in suspend mode or when power is removed from the device.

8.5 Remote Wakeup Indicator (SUSP_IND)

The remote wakeup indicator feature uses the SUSP_IND as a side band signal to wake up the host when in suspend. This feature is enabled and disabled via the HUB_RESUME_INHIBIT configuration bit in the hub configuration space register CFG3. The only way to control the bit is by configuration EEPROM, SMBus or internal ROM default setting. The state is only modified during a power on reset, or hardware reset. No dynamic reconfiguring of this capability is possible.

When HUB_RESUME_INHIBIT = '0', [Normal Resume Behavior](#) per the USB 2.0 specification

When HUB_RESUME_INHIBIT = '1', [Modified Resume Behavior](#) is enabled

Refer to the following subsections for additional details.

8.5.1 NORMAL RESUME BEHAVIOR

VBUS_DET is used to detect presence of the Host. If VBUS_DET = '1', then D+ pull-up is asserted and normal USB functionality is enabled. The SUSP_IND provides an indication of the active or suspended state of the hub.

The Hub will drive a 'K' on the upstream port if required to do so by USB protocol.

If VBUS_DET = '0', then the D+ pull-up is negated. If battery charging is not enabled, the internal hub logic will be reset, thus negating all downstream ports and associated downstream VBUS enable signals. The hub will need to be re-enumerated to function, much like a new connect or after a complete system reset.

8.5.2 MODIFIED RESUME BEHAVIOR

When the modified resume feature is enabled, the hub functions as follows:

VBUS_DET is used to detect presence of the Host. If VBUS_DET = '1', then D+ pull-up is asserted and normal USB functionality is enabled. SUSP_IND provides an indication of the active or suspended state of the hub.

The device will drive a 'K' on the upstream port and downstream ports if required to do so by USB protocol. The device will act as a controlling hub if required to do so by the USB protocol.

If VBUS_DET = '0', then the D+ pull-up is negated, but the hub will not be internally reset. It will power-on the downstream ports. The hub is able to continue to detect downstream remote wake events.

SUSP_IND provides an indication of the active or suspended state of the hub.

If a USB 2.0 specification compliant resume or wake event is detected by the device, the device is remote wake enabled, and a port status change event occurs, SUSP_IND will be driven for the time given in the GLOBAL_RESUME_TIME register.

If a remote wake event is detected on a downstream port:

1. Device disconnect
2. Device connect
3. A currently connected device requests remote wake-up.

Note: Downstream resume events are filtered for approximately 100uS by internal logic.

The device will not drive a 'K' on the upstream port. Instead, the SUSP_IND will be driven for approximately 14 ms. The 'K' is not driven upstream because this would potentially back drive a powered-down host. The device will drive RESUME to only the downstream ports which transmitted the remote wake signal per the requirements of the USB 2.0 specification for controlling hub behavior.

Note: SUSP_IND is a one shot event. It will assert with each wake event detection. It will not repeatedly assert in proxy for downstream devices.

For the case where the Host responds and turns on VBUS and can drive a 'K' downstream within the 14 ms time frame of a standard resume (measured from the SUSP_IND pin), then the hub detects the 'K'. It will discontinue "Controlling Hub" activities, drive resume signaling on any other ports, and function as expected per the USB 2.0 Specification with respect to a resume event. It will permit the host to take over resume signaling.

For the case where the host is not able to drive a 'K' within the 14 ms time frame, the hub will stop sending a 'K' on the upstream and downstream ports. It must follow through as a controlling hub and properly terminate the resume with either an EOP or with HS terminations as is currently implemented in the selective resume case, per the USB specification.

8.6 High Speed Indicator (HS_IND)

The HS_IND pin can be used to drive an LED. The active state of the LED will be determined as follows:

- If CFG_SEL1 = '0', HS_IND is active high.
- If CFG_SEL1 = '1', then HS_IND is active low.

Assertion of HS_IND indicates the device is connected at high speed. Negation of HS_IND indicates the device is connected at full speed.

Note: This pin shares functionality with the CFG_SEL1 configuration strap. The logic state of this pin is internally latched on the rising edge of RESET_N (RESET_N negation), and is used to determine the hub configuration method. Refer to [Section 6.3.2, "Configuration Select \(CFG_SEL\[1:0\]\)," on page 24](#) for additional information.

9.0 OPERATIONAL CHARACTERISTICS

9.1 Absolute Maximum Ratings*

VBAT Supply Voltage (Note 9-1)	0 V to +5.5 V
+3.3 V Supply Voltage (VDD33, VDDA33) (Note 9-1)	0 V to +3.6 V
Positive voltage on input signal pins, with respect to ground (Note 9-2)	3.6 V
Negative voltage on input signal pins, with respect to ground	-0.5 V
Positive voltage on XTAL1/REFCLK, with respect to ground	3.6 V
Positive voltage on USB DP/DM signals, with respect to ground (Note 9-3)	5.5 V
Storage Temperature	-55°C to +150°C
Lead Temperature Range	Refer to JEDEC Spec. J-STD-020
HBM ESD Performance	JEDEC Class 3A

Note 9-1 When powering this device from laboratory or system power supplies, it is important that the absolute maximum ratings not be exceeded or device failure can result. Some power supplies exhibit voltage spikes on their outputs when AC power is switched on or off. In addition, voltage transients on the AC power line may appear on the DC output. If this possibility exists, it is suggested to use a clamp circuit.

Note 9-2 This rating does not apply to the following signals: All USB DM/DP pins, XTAL1/REFCLK, XTAL2.

Note 9-3 This rating applies only when VDD33 is powered.

*Stresses exceeding those listed in this section could cause permanent damage to the device. This is a stress rating only. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Functional operation of the device at any condition exceeding those indicated in [Section 9.2, "Operating Conditions***"](#), [Section 9.5, "DC Specifications"](#), or any other applicable section of this specification is not implied. Note, device signals are NOT 5 volt tolerant unless specified otherwise.

9.2 Operating Conditions**

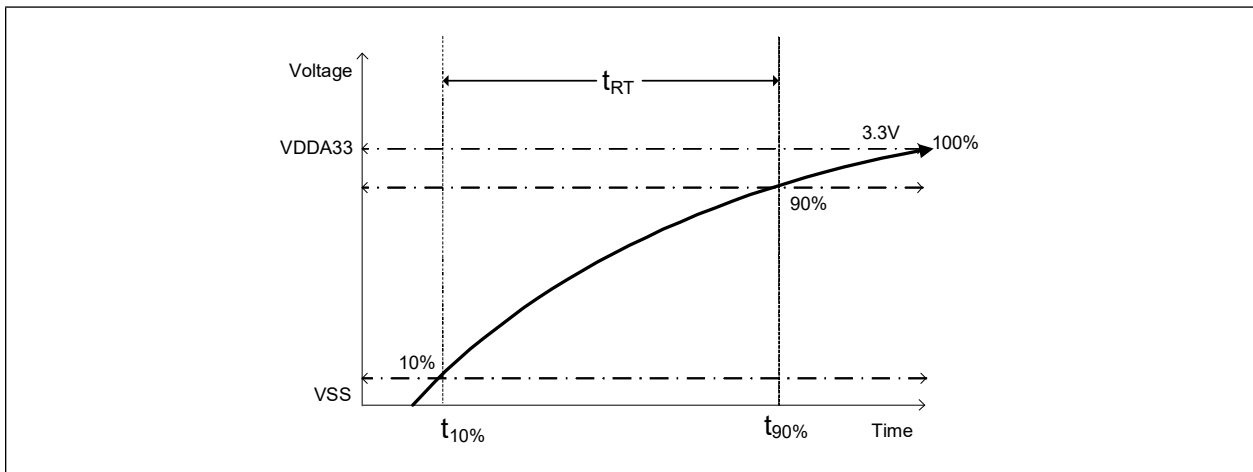
VBAT Supply Voltage	+3.0 V to +5.5 V
+3.3 V Supply Voltage (VDD33, VDDA33).....	+3.0 V to 3.6 V
Power Supply Rise Time	Note 9-4
Ambient Operating Temperature in Still Air (T_A).....	Note 9-5

Note 9-4 The power supply rise time requirements vary dependent on the usage of the external reset (RESET_N). If RESET_N is asserted at power-on, the power supply rise time must be 10mS or less ($t_{RT(max)} = 10mS$). If RESET_N is not used at power-on (tied high), the power supply rise time must be 1mS or less ($t_{RT(max)} = 1mS$). Figure 9-1 illustrates the supply rise time requirements.

Note 9-5 -40°C to +85°C

**Proper operation of the device is ensured only within the ranges specified in this section.

FIGURE 9-1: SUPPLY RISE TIME MODEL



9.3 Power Consumption

This section details the power consumption of the device as measured during various modes of operation. Power dissipation is determined by temperature, supply voltage, and external source/sink requirements.

9.3.1 OPERATIONAL / UNCONFIGURED

TABLE 9-1: OPERATIONAL/UNCONFIGURED POWER CONSUMPTION (USB UPSTREAM)

	Typical (mA)	Maximum (mA)
	VBAT	VBAT
HS Host / 1 HS Device	70	85
HS Host / 2 HS Devices	105	120
HS Host / 4 HS Devices	165	180
HS Host / 1 FS Device	50	65
HS Host / 2 FS Devices	60	70
HS Host / 4 FS Devices	65	75
Unconfigured	30	-

9.3.2 SUSPEND / STANDBY

TABLE 9-2: SUSPEND/STANDBY POWER CONSUMPTION

Mode	Symbol	Typical @ 25°C	Commercial MAX	Industrial MAX	Unit
Suspend	I_{VBAT}	320	1200	2000	uA
Standby	I_{VBAT}	0.4	2.0	2.4	uA
Note: Typical values measured with VBAT = 4.2V. Maximum values measured with VBAT = 5.5V.					

9.4 Package Thermal Specifications

Thermal parameters are measured or estimated for devices with the ground soldered to thermal vias in a multilayer 2S2P PCB per JESD51. Thermal resistance is measured from the die to the ambient air. The values provided are based on the package body, die size, maximum power consumption, 85°C ambient temperature, and 125°C junction temperature of the die.

TABLE 9-3: PACKAGE THERMAL RESISTANCE PARAMETERS

Symbol	°C/W	Velocity (Meter/s)
Θ_{JA}	35	0
	30	1
	27	2.5
Θ_{JB}	20	-
Θ_{JC}	3.4	-
Ψ_{JT}	0.3	0
Ψ_{JB}	19	0

Use the following formulas to calculate the junction temperature:

$$T_J = P \times \Theta_{JA} + T_A$$

$$T_J = P \times \Psi_{JT} + T_T$$

$$T_J = P \times \Theta_{JC} + T_C$$

TABLE 9-4: PACKAGE THERMALS LEGEND

Symbol	Description
T_J	Die Junction Temperature
P	Power dissipated
Θ_{JA}	Thermal Resistance Junction to Ambient
Θ_{JC}	Thermal Resistance Junction to Case
Ψ_{JT}	Junction to Top of Package Characterization Parameter
T_A	Ambient Temperature
T_C	Package Case Temperature
T_T	Top of Package Temperature

9.5 DC Specifications

TABLE 9-5: DC ELECTRICAL CHARACTERISTICS

Parameter	Symbol	MIN	TYP	MAX	Units	Notes
IS Type Input Buffer						
Low Input Level	V_{IL}	-0.3		0.8	V	
High Input Level	V_{IH}	2.0		3.6	V	
I_RST Type Input Buffer						
Low Input Level	V_{IL}	-0.3		0.4	V	
High Input Level	V_{IH}	1.25		3.6	V	
I_SMB Type Input Buffer						
Low Input Level	V_{IL}	-0.3		0.35	V	
High Input Level	V_{IH}	1.25		3.6	V	
O8 Type Buffers						
Low Output Level	V_{OL}			0.4	V	$I_{OL} = 8\text{ mA}$
High Output Level	V_{OH}	$V_{DD33} - 0.4$			V	$I_{OH} = -8\text{ mA}$
OD8 Type Buffer						
Low Output Level	V_{OL}			0.4	V	$I_{OL} = 8\text{ mA}$
OD12 Type Buffer						
Low Output Level	V_{OL}			0.4	V	$I_{OL} = 12\text{ mA}$
ICLK Type Buffer (XTAL1/REFCLK Input)						
Low Input Level	V_{IL}	-0.3		0.35	V	
High Input Level	V_{IH}	0.8		3.6	V	

9.6 AC Specifications

This section details the various AC timing specifications of the device.

9.6.1 POWER-ON CONFIGURATION STRAP VALID TIMING

Figure 9-2 illustrates the configuration strap timing requirements, in relation to power-on, for applications where RESET_N is not used at power-on. The operational level (V_{opp}) for the external power supply is detailed in [Section 9.2, "Operating Conditions**,"](#) on page 35.

Note: For RESET_N configuration strap timing requirements, refer to [Section 9.6.2, "Reset and Configuration Strap Timing,"](#) on page 38.

FIGURE 9-2: POWER-ON CONFIGURATION STRAP VALID TIMING

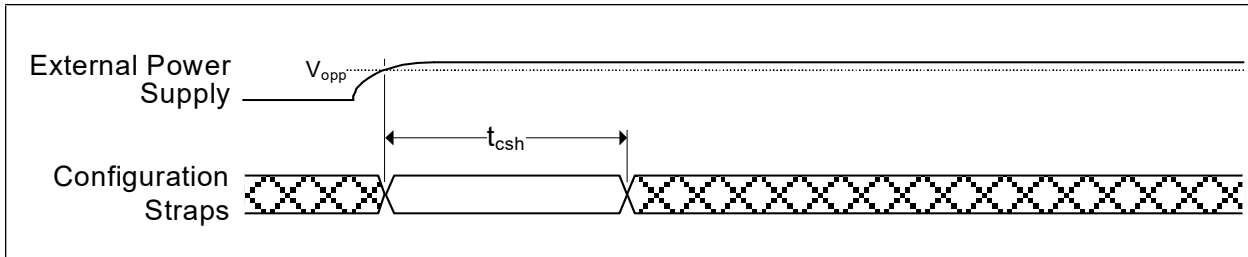


TABLE 9-6: POWER-ON CONFIGURATION STRAP VALID TIMING

Symbol	Description	MIN	TYP	MAX	Units
t_{csh}	Configuration strap hold after external power supply at operational level	1			ms

9.6.2 RESET AND CONFIGURATION STRAP TIMING

Figure 9-3 illustrates the RESET_N timing requirements and its relation to the configuration strap signals. Assertion of RESET_N is not a requirement. However, if used, it must be asserted for the minimum period specified.

Refer to [Section 8.3, "Resets,"](#) on page 31 for additional information on resets. Refer to [Section 6.3, "Device Configuration Straps,"](#) on page 24 for additional information on configuration straps.

FIGURE 9-3: RESET AND CONFIGURATION STRAP TIMING

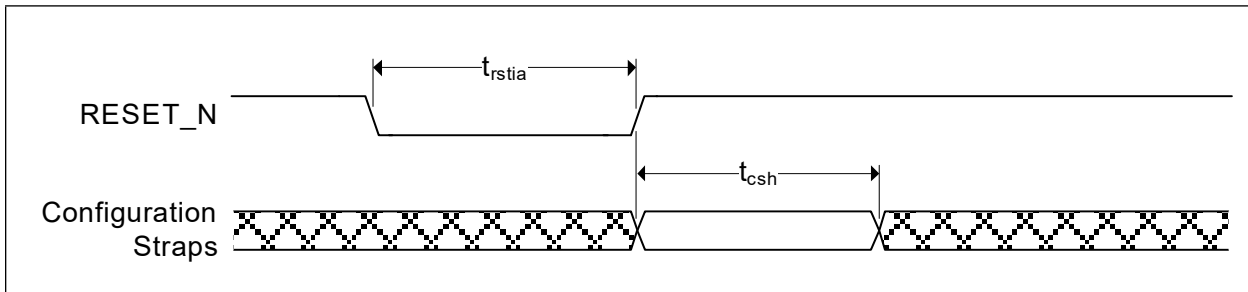


TABLE 9-7: RESET_N CONFIGURATION STRAP TIMING

Symbol	Description	MIN	TYP	MAX	Units
t_{rstia}	RESET_N input assertion time	5			us
t_{csh}	Configuration strap hold after RESET_N deassertion	1			ms

9.6.3 POWER-ON OR RESET TO SMBUS CLIENT READY TIMING

Figure 9-4 illustrates the SMBus Slave interface readiness in relation to power-on or deassertion of RESET_N. In order to ensure reliable SMBus client operation, the SMBus host must allow the bus to remain idle until $t_{\text{SMBUS_RDY}}$ timing has been met. The operational levels (V_{opp}) for the external power supplies are detailed in Section 9.2, "Operating Conditions***".

FIGURE 9-4: POWER-ON OR RESET TO SMBUS CLIENT READY TIMING

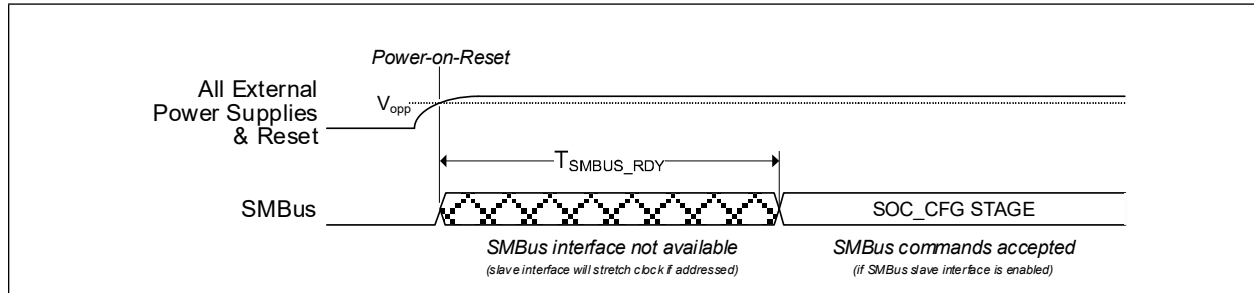


TABLE 9-8: POWER-ON OR RESET TO SMBUS CLIENT READY TIMING

Symbol	Description	MIN	TYP	MAX	Units
$t_{\text{SMBUS_RDY}}$	Power-on or RESET_N deassertion to SMBus ready			250	ms

9.6.4 USB ATTACH COMMAND TO SMBUS CLIENT READY TIMING

Figure 9-5 illustrates the SMBus Client interface readiness in relation to ACK of the Slave interface to the "USB Attach with SMBus Runtime Access" (AA55h) from the SMBus Host. In order to ensure reliable SMBus client operation, the SMBus master must allow the bus to remain idle after issuing the "USB Attach with SMBus Runtime Access" until $t_{\text{ATTACH_RDY}}$ timing has been met.

Note: When accessing SMBus during runtime, it is critical to force some clocks to stay on. If this step is not taken, the SMBus client interface will not be accessible while the hub is placed into a Suspend state by the host.

FIGURE 9-5: USB ATTACH COMMAND TO SMBUS SLAVE READY TIMING

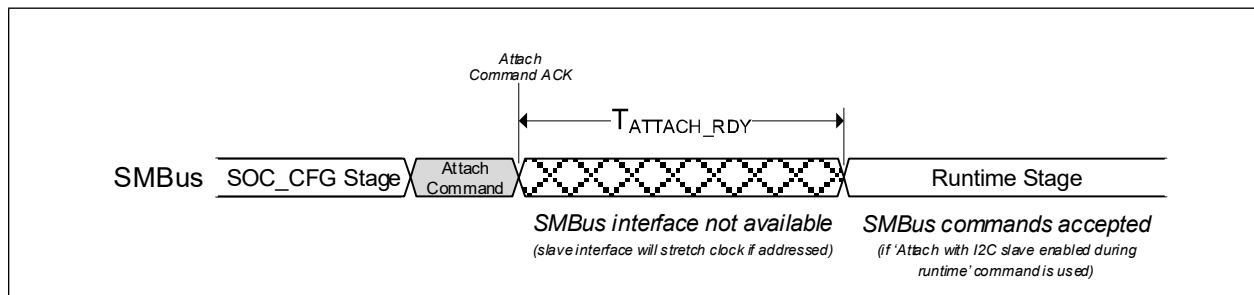


TABLE 9-9: POWER-ON OR RESET TO SMBUS SLAVE READY TIMING

Symbol	Description	MIN	TYP	MAX	Units
$t_{\text{ATTACH_RDY}}$	USB Attach command to SMBus ready (Note 9-1)	30		65	ms

Note 9-1 The amount of OTP configuration memory utilized impacts the observed timing. The minimum timing correlates to a device without any OTP configuration memory programming. The maximum time was derived from devices with all available OTP memory programmed.

9.6.5 USB TIMING

All device USB signals conform to the voltage, power, and timing characteristics/specifications as set forth in the *Universal Serial Bus Specification*. Please refer to the *Universal Serial Bus Specification*, Revision 2.0, available at <http://www.usb.org>.

9.6.6 SMBUS TIMING

All device SMBus signals conform to the voltage, power, and timing characteristics/specifications as set forth in the *System Management Bus Specification*. Please refer to the *System Management Bus Specification*, Version 1.0, available at <http://smbus.org/specs>.

9.6.7 I²C TIMING

All device I²C signals conform to the 100KHz Standard Mode (Sm) voltage, power, and timing characteristics/specifications as set forth in the *I²C-Bus Specification*. Please refer to the *I²C-Bus Specification*, available at <http://www.nxp.com>.

9.7 Clock Specifications

The device can accept either a 24 MHz crystal or a 24 MHz single-ended clock oscillator input. If the single-ended clock oscillator method is implemented, XTAL1 should be left unconnected and REFCLK should be driven with a clock that adheres to the specifications outlined in [Section 9.7.2, "External Reference Clock \(REFCLK\)"](#).

9.7.1 OSCILLATOR/CRYSTAL

It is recommended that a crystal utilizing matching parallel load capacitors be used for the crystal input/output signals (XTAL1/XTAL2). See [Table 9-10](#) for the recommended crystal specifications.

TABLE 9-10: CRYSTAL SPECIFICATIONS

Parameter	Symbol	MIN	NOM	MAX	Units	Notes
Crystal Cut		AT, typ				
Crystal Oscillation Mode		Fundamental Mode				
Crystal Calibration Mode		Parallel Resonant Mode				
Frequency	F _{fund}	-	24.000	-	MHz	
Total Allowable PPM Budget		-	-	+/-350	PPM	
Operating Temperature Range		Note 9-2	-	Note 9-3	°C	

Note 9-2 0°C for commercial version, -40°C for industrial version.

Note 9-3 +70°C for commercial version, +85°C for industrial version.

9.7.2 EXTERNAL REFERENCE CLOCK (REFCLK)

The following input clock specifications are suggested:

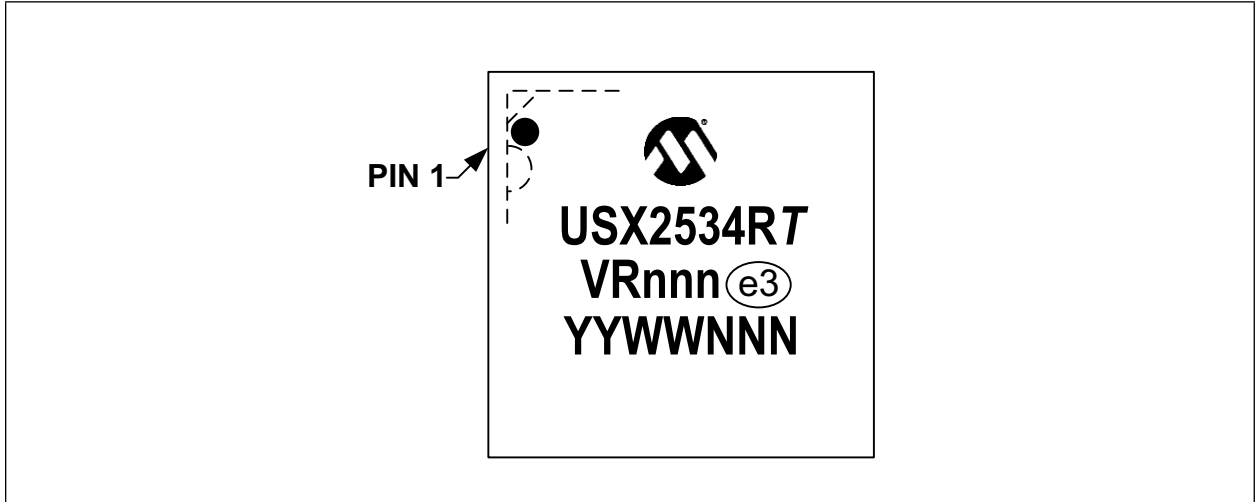
- 24 MHz ± 350 PPM

Note: The external clock is recommended to conform to the signalling levels designated in the JEDEC specification on 1.2V CMOS Logic. XTAL2 should be treated as a no connect when an external clock is supplied.

10.0 PACKAGE INFORMATION

10.1 Top Marking

FIGURE 10-1: TOP MARKING



Legend:

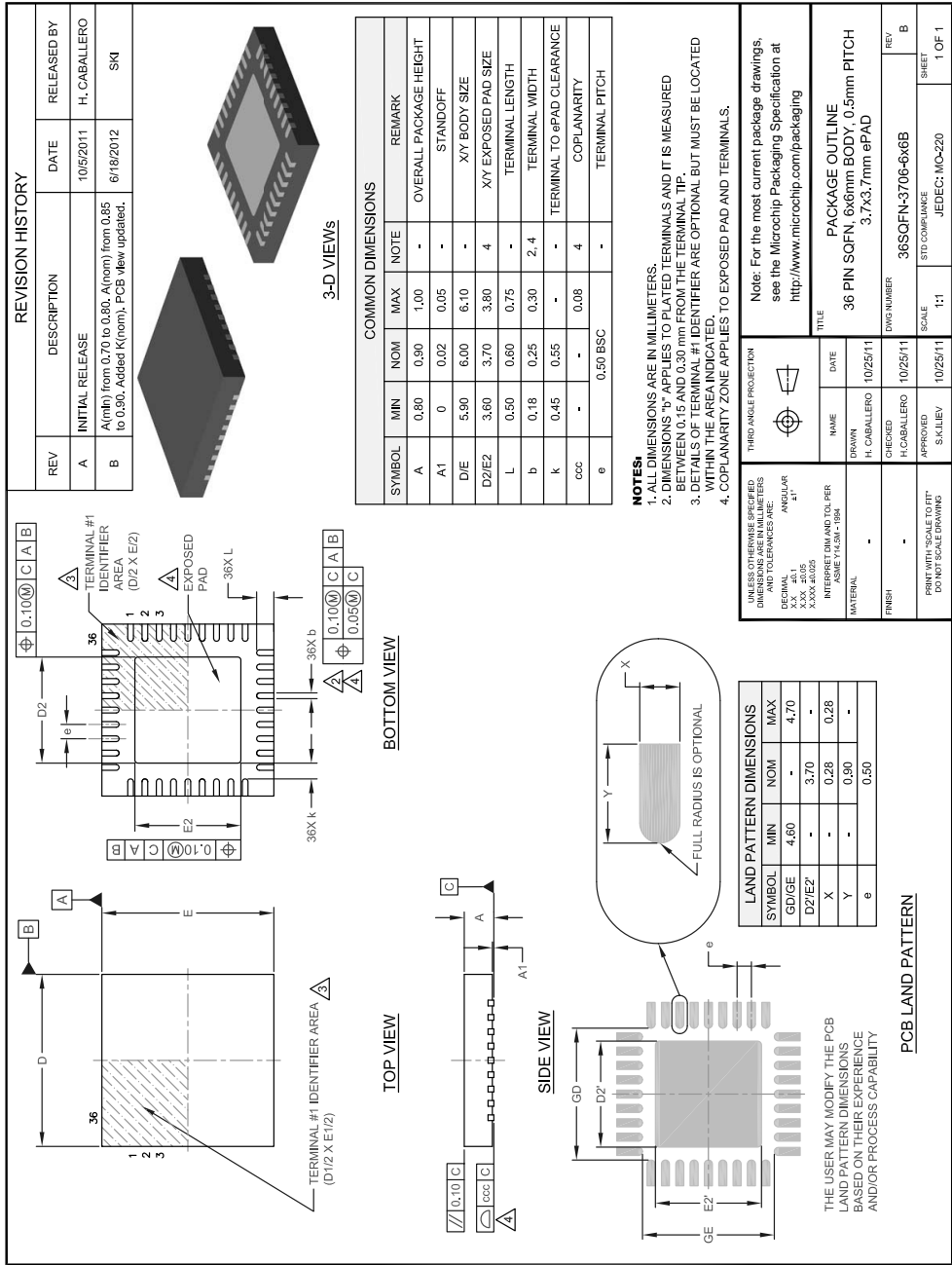
T	Temperature range designator ($i = -40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$)
V	Automotive marker (V = AEC-Q100 Grade3)
R	Product revision (B = Revision B)
nnn	Internal code
e3	Pb-free JEDEC [®] designator for Matte Tin (Sn)
YY	Year code (last two digits of calendar year)
WW	Week code (week of January 1 is week '01')
NNN	Alphanumeric traceability code

Note: In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for customer-specific information

10.2 Package Drawing & Dimensions

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>.

FIGURE 10-2: 36-SQFN PACKAGE DRAWING



APPENDIX A: DATA SHEET REVISION HISTORY**TABLE A-1: REVISION HISTORY**

REVISION LEVEL & DATE	SECTION/FIGURE/ENTRY	CORRECTION
DS00005407A (06-04-24)		Initial Release

THE MICROCHIP WEB SITE

Microchip provides online support via our WWW site at www.microchip.com. This web site is used as a means to make files and information easily available to customers. Accessible by using your favorite Internet browser, the web site contains the following information:

- **Product Support** – Data sheets and errata, application notes and sample programs, design resources, user's guides and hardware support documents, latest software releases and archived software
- **General Technical Support** – Frequently Asked Questions (FAQ), technical support requests, online discussion groups, Microchip consultant program member listing
- **Business of Microchip** – Product selector and ordering guides, latest Microchip press releases, listing of seminars and events, listings of Microchip sales offices, distributors and factory representatives

CUSTOMER CHANGE NOTIFICATION SERVICE

Microchip's customer notification service helps keep customers current on Microchip products. Subscribers will receive e-mail notification whenever there are changes, updates, revisions or errata related to a specified product family or development tool of interest.

To register, access the Microchip web site at www.microchip.com. Under "Support", click on "Customer Change Notification" and follow the registration instructions.

CUSTOMER SUPPORT

Users of Microchip products can receive assistance through several channels:

- Distributor or Representative
- Local Sales Office
- Field Application Engineer (FAE)
- Technical Support

Customers should contact their distributor, representative or field application engineer (FAE) for support. Local sales offices are also available to help customers. A listing of sales offices and locations is included in the back of this document.

Technical support is available through the web site at: <http://www.microchip.com/support>

PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

PART NO. **[X]⁽¹⁾** - **X** / **XXX** **XXX**

Device **Tape & Reel Option** **Temp. Range** **Package** **Automotive Code**

Device: USX2534R

Tape & Reel Option: Blank = Standard packaging (tray)
 T = Tape and Reel⁽¹⁾

Temperature Range: I = -40°C to+85°C (AEC-Q100 Grade 3)

Package: UDX = 36-pin SQFN

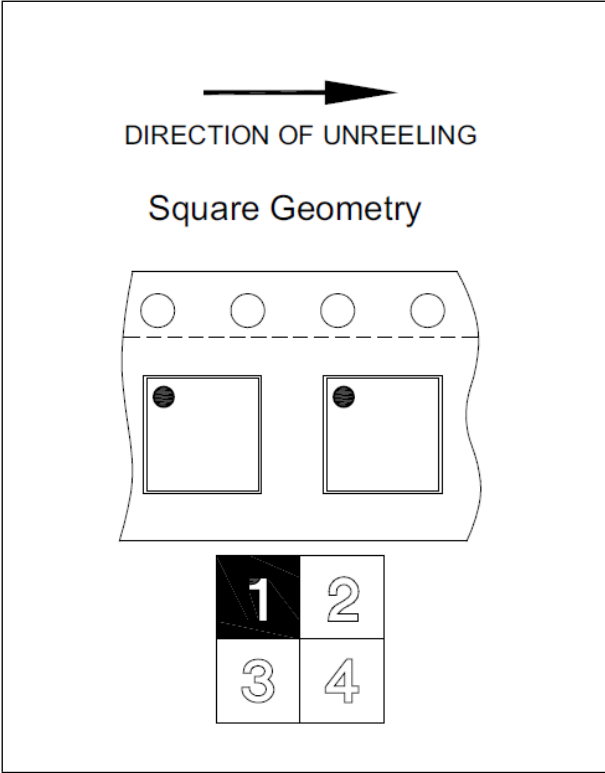
Automotive Code Vxx = 3 character code with "V" prefix, specifying automotive product.

Examples:

a) USX2534R-I/UDXVAO: Tray, AEC-Q100 Grade 3, 36-pin SQFN

b) USX2534RT-I/UDXVAO: Tape & Reel, AEC-Q100 Grade 3, 36-pin SQFN

Note 1: Tape and Reel identifier only appears in the catalog part number description. This identifier is used for ordering purposes and is not printed on the device package. Check with your Microchip Sales Office for package availability with the Tape and Reel option.



Note the following details of the code protection feature on Microchip products:

- Microchip products meet the specifications contained in their particular Microchip Data Sheet.
- Microchip believes that its family of products is secure when used in the intended manner, within operating specifications, and under normal conditions.
- Microchip values and aggressively protects its intellectual property rights. Attempts to breach the code protection features of Microchip product is strictly prohibited and may violate the Digital Millennium Copyright Act.
- Neither Microchip nor any other semiconductor manufacturer can guarantee the security of its code. Code protection does not mean that we are guaranteeing the product is "unbreakable". Code protection is constantly evolving. Microchip is committed to continuously improving the code protection features of our products.

This publication and the information herein may be used only with Microchip products, including to design, test, and integrate Microchip products with your application. Use of this information in any other manner violates these terms. Information regarding device applications is provided only for your convenience and may be superseded by updates. It is your responsibility to ensure that your application meets with your specifications. Contact your local Microchip sales office for additional support or, obtain additional support at <https://www.microchip.com/en-us/support/design-help/client-support-services>.

THIS INFORMATION IS PROVIDED BY MICROCHIP "AS IS". MICROCHIP MAKES NO REPRESENTATIONS OR WARRANTIES OF ANY KIND WHETHER EXPRESS OR IMPLIED, WRITTEN OR ORAL, STATUTORY OR OTHERWISE, RELATED TO THE INFORMATION INCLUDING BUT NOT LIMITED TO ANY IMPLIED WARRANTIES OF NON-INFRINGEMENT, MERCHANTABILITY, AND FITNESS FOR A PARTICULAR PURPOSE, OR WARRANTIES RELATED TO ITS CONDITION, QUALITY, OR PERFORMANCE.

IN NO EVENT WILL MICROCHIP BE LIABLE FOR ANY INDIRECT, SPECIAL, PUNITIVE, INCIDENTAL, OR CONSEQUENTIAL LOSS, DAMAGE, COST, OR EXPENSE OF ANY KIND WHATSOEVER RELATED TO THE INFORMATION OR ITS USE, HOWEVER CAUSED, EVEN IF MICROCHIP HAS BEEN ADVISED OF THE POSSIBILITY OR THE DAMAGES ARE FORESEEABLE. TO THE FULLEST EXTENT ALLOWED BY LAW, MICROCHIP'S TOTAL LIABILITY ON ALL CLAIMS IN ANY WAY RELATED TO THE INFORMATION OR ITS USE WILL NOT EXCEED THE AMOUNT OF FEES, IF ANY, THAT YOU HAVE PAID DIRECTLY TO MICROCHIP FOR THE INFORMATION.

Use of Microchip devices in life support and/or safety applications is entirely at the buyer's risk, and the buyer agrees to defend, indemnify and hold harmless Microchip from any and all damages, claims, suits, or expenses resulting from such use. No licenses are conveyed, implicitly or otherwise, under any Microchip intellectual property rights unless otherwise stated.

Trademarks

The Microchip name and logo, the Microchip logo, Adaptec, AVR, AVR logo, AVR Freaks, BesTime, BitCloud, CryptoMemory, CryptoRF, dsPIC, flexPWR, HELDO, IGLOO, JukeBlox, KeeLoq, Klear, LANCheck, LinkMD, maxStylus, maxTouch, MediaLB, megaAVR, Microsemi, Microsemi logo, MOST, MOST logo, MPLAB, OptoLyzer, PIC, picoPower, PICSTART, PIC32 logo, PolarFire, Prochip Designer, QTouch, SAM-BA, SenGenuity, SpyNIC, SST, SST Logo, SuperFlash, Symmetricom, SyncServer, Tachyon, TimeSource, tinyAVR, UNI/O, Vectron, and XMEGA are registered trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

AgileSwitch, ClockWorks, The Embedded Control Solutions Company, EtherSynch, Flashtec, Hyper Speed Control, HyperLight Load, Libero, motorBench, mTouch, Powermite 3, Precision Edge, ProASIC, ProASIC Plus, ProASIC Plus logo, Quiet-Wire, SmartFusion, SyncWorld, TimeCesium, TimeHub, TimePictra, TimeProvider, and ZL are registered trademarks of Microchip Technology Incorporated in the U.S.A.

Adjacent Key Suppression, AKS, Analog-for-the-Digital Age, Any Capacitor, AnyIn, AnyOut, Augmented Switching, BlueSky, BodyCom, Clockstudio, CodeGuard, CryptoAuthentication, CryptoAutomotive, CryptoCompanion, CryptoController, dsPICDEM, dsPICDEM.net, Dynamic Average Matching, DAM, ECAN, Espresso T1S, EtherGREEN, EyeOpen, GridTime, IdealBridge, IGaT, In-Circuit Serial Programming, ICSP, INICnet, Intelligent Paralleling, IntelliMOS, Inter-Chip Connectivity, JitterBlocker, Knob-on-Display, MarginLink, maxCrypto, maxView, memBrain, Mindi, MiWi, MPASM, MPF, MPLAB Certified logo, MPLIB, MPLINK, mSiC, MultiTRAK, NetDetach, Omniscient Code Generation, PICDEM, PICDEM.net, PICKit, PICtail, Power MOS IV, Power MOS 7, PowerSmart, PureSilicon, QMatrix, REAL ICE, Ripple Blocker, RTAX, RTG4, SAM-ICE, Serial Quad I/O, SimpleMAP, SimpliPHY, SmartBuffer, SmartHLS, SMART-I.S., storClad, SQL, SuperSwitcher, SuperSwitcher II, Switchtec, SynchroPHY, Total Endurance, Trusted Time, TSHARC, Turing, USBCheck, VariSense, VectorBlox, VeriPHY, ViewSpan, WiperLock, XpressConnect, and ZENA are trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

SQTP is a service mark of Microchip Technology Incorporated in the U.S.A.

The Adaptec logo, Frequency on Demand, Silicon Storage Technology, and Symmcom are registered trademarks of Microchip Technology Inc. in other countries.

GestIC is a registered trademark of Microchip Technology Germany II GmbH & Co. KG, a subsidiary of Microchip Technology Inc., in other countries.

All other trademarks mentioned herein are property of their respective companies.

© 2024, Microchip Technology Incorporated and its subsidiaries.

All Rights Reserved.

ISBN: 9781668343609

For information regarding Microchip's Quality Management Systems, please visit www.microchip.com/quality.



Worldwide Sales and Service

AMERICAS

Corporate Office
2355 West Chandler Blvd.
Chandler, AZ 85224-6199
Tel: 480-792-7200
Fax: 480-792-7277
Technical Support:
<http://www.microchip.com/support>
Web Address:
www.microchip.com

Atlanta
Duluth, GA
Tel: 678-957-9614
Fax: 678-957-1455

Austin, TX
Tel: 512-257-3370

Boston
Westborough, MA
Tel: 774-760-0087
Fax: 774-760-0088

Chicago
Itasca, IL
Tel: 630-285-0071
Fax: 630-285-0075

Dallas
Addison, TX
Tel: 972-818-7423
Fax: 972-818-2924

Detroit
Novi, MI
Tel: 248-848-4000

Houston, TX
Tel: 281-894-5983

Indianapolis
Noblesville, IN
Tel: 317-773-8323
Fax: 317-773-5453
Tel: 317-536-2380

Los Angeles
Mission Viejo, CA
Tel: 949-462-9523
Fax: 949-462-9608
Tel: 951-273-7800

Raleigh, NC
Tel: 919-844-7510

New York, NY
Tel: 631-435-6000

San Jose, CA
Tel: 408-735-9110
Tel: 408-436-4270

Canada - Toronto
Tel: 905-695-1980
Fax: 905-695-2078

ASIA/PACIFIC

Australia - Sydney
Tel: 61-2-9868-6733

China - Beijing
Tel: 86-10-8569-7000

China - Chengdu
Tel: 86-28-8665-5511

China - Chongqing
Tel: 86-23-8980-9588

China - Dongguan
Tel: 86-769-8702-9880

China - Guangzhou
Tel: 86-20-8755-8029

China - Hangzhou
Tel: 86-571-8792-8115

China - Hong Kong SAR
Tel: 852-2943-5100

China - Nanjing
Tel: 86-25-8473-2460

China - Qingdao
Tel: 86-532-8502-7355

China - Shanghai
Tel: 86-21-3326-8000

China - Shenyang
Tel: 86-24-2334-2829

China - Shenzhen
Tel: 86-755-8864-2200

China - Suzhou
Tel: 86-186-6233-1526

China - Wuhan
Tel: 86-27-5980-5300

China - Xian
Tel: 86-29-8833-7252

China - Xiamen
Tel: 86-592-2388138

China - Zhuhai
Tel: 86-756-3210040

ASIA/PACIFIC

India - Bangalore
Tel: 91-80-3090-4444

India - New Delhi
Tel: 91-11-4160-8631

India - Pune
Tel: 91-20-4121-0141

Japan - Osaka
Tel: 81-6-6152-7160

Japan - Tokyo
Tel: 81-3-6880-3770

Korea - Daegu
Tel: 82-53-744-4301

Korea - Seoul
Tel: 82-2-554-7200

Malaysia - Kuala Lumpur
Tel: 60-3-7651-7906

Malaysia - Penang
Tel: 60-4-227-8870

Philippines - Manila
Tel: 63-2-634-9065

Singapore
Tel: 65-6334-8870

Taiwan - Hsin Chu
Tel: 886-3-577-8366

Taiwan - Kaohsiung
Tel: 886-7-213-7830

Taiwan - Taipei
Tel: 886-2-2508-8600

Thailand - Bangkok
Tel: 66-2-694-1351

Vietnam - Ho Chi Minh
Tel: 84-28-5448-2100

EUROPE

Austria - Wels
Tel: 43-7242-2244-39
Fax: 43-7242-2244-393

Denmark - Copenhagen
Tel: 45-4485-5910
Fax: 45-4485-2829

Finland - Espoo
Tel: 358-9-4520-820

France - Paris
Tel: 33-1-69-53-63-20
Fax: 33-1-69-30-90-79

Germany - Garching
Tel: 49-8931-9700

Germany - Haan
Tel: 49-2129-3766400

Germany - Heilbronn
Tel: 49-7131-72400

Germany - Karlsruhe
Tel: 49-721-625370

Germany - Munich
Tel: 49-89-627-144-0
Fax: 49-89-627-144-44

Germany - Rosenheim
Tel: 49-8031-354-560

Israel - Hod Hasharon
Tel: 972-9-775-5100

Italy - Milan
Tel: 39-0331-742611
Fax: 39-0331-466781

Italy - Padova
Tel: 39-049-7625286

Netherlands - Drunen
Tel: 31-416-690399
Fax: 31-416-690340

Norway - Trondheim
Tel: 47-7288-4388

Poland - Warsaw
Tel: 48-22-3325737

Romania - Bucharest
Tel: 40-21-407-87-50

Spain - Madrid
Tel: 34-91-708-08-90
Fax: 34-91-708-08-91

Sweden - Gothenberg
Tel: 46-31-704-60-40

Sweden - Stockholm
Tel: 46-8-5090-4654

UK - Wokingham
Tel: 44-118-921-5800
Fax: 44-118-921-5820